

MANUAL DE SERVIÇO

LEVEL 3

Brazilian Model

Ver. 1.1 2006.06

Revision History

Instruções de
Acrobat Reader

Memória Interna
na PLACA



Link

• NOTA DE SERVIÇO

• DIAGRAMAS ESQUEMÁTICOS

• PLACAS DE CIRCUITO IMPRESSO

• LISTA DE PEÇAS PARA REPARO

Note :
The components identified by mark \triangle or dotted line with mark \triangle are critical for safety.
Replace only with part number specified.

Note :
Les composants identifiés par une marque \triangle sont critiques pour la sécurité.
Ne les remplacer que par une pièce portant le numéro spécifié.

DIGITAL STILL CAMERA
SONY[®]



Cyber-shot
Digital Still Camera



SAFETY CHECK-OUT

After correcting the original service problem, perform the following safety checks before releasing the set to the customer.

1. Check the area of your repair for unsoldered or poorly-soldered connections. Check the entire board surface for solder splashes and bridges.
2. Check the interboard wiring to ensure that no wires are "pinched" or contact high-wattage resistors.
3. Look for unauthorized replacement parts, particularly transistors, that were installed during a previous repair. Point them out to the customer and recommend their replacement.
4. Look for parts which, through functioning, show obvious signs of deterioration. Point them out to the customer and recommend their replacement.
5. Check the B+ voltage to see it is at the values specified.
6. Flexible Circuit Board Repairing
 - Keep the temperature of the soldering iron around 270°C during repairing.
 - Do not touch the soldering iron on the same conductor of the circuit board (within 3 times).
 - Be careful not to apply force on the conductor when soldering or unsoldering.

Unleaded solder

Boards requiring use of unleaded solder are printed with the lead-free mark (LF) indicating the solder contains no lead.

(Caution: Some printed circuit boards may not come printed with the lead free mark due to their particular size.)



: LEAD FREE MARK

Unleaded solder has the following characteristics.

- Unleaded solder melts at a temperature about 40°C higher than ordinary solder.
Ordinary soldering irons can be used but the iron tip has to be applied to the solder joint for a slightly longer time.
Soldering irons using a temperature regulator should be set to about 350°C.
Caution: The printed pattern (copper foil) may peel away if the heated tip is applied for too long, so be careful!
- Strong viscosity
Unleaded solder is more viscous (sticky, less prone to flow) than ordinary solder so use caution not to let solder bridges occur such as on IC pins, etc.
- Usable with ordinary solder
It is best to use only unleaded solder but unleaded solder may also be added to ordinary solder.

SAFETY-RELATED COMPONENT WARNING!!

COMPONENTS IDENTIFIED BY MARK \triangle OR DOTTED LINE WITH MARK \triangle ON THE SCHEMATIC DIAGRAMS AND IN THE PARTS LIST ARE CRITICAL TO SAFE OPERATION. REPLACE THESE COMPONENTS WITH SONY PARTS WHOSE PART NUMBERS APPEAR AS SHOWN IN THIS MANUAL OR IN SUPPLEMENTS PUBLISHED BY SONY.

ATTENTION AU COMPOSANT AYANT RAPPORT À LA SÉCURITÉ!

LES COMPOSANTS IDENTIFIÉS PAR UNE MARQUE \triangle SUR LES DIAGRAMMES SCHÉMATIQUES ET LA LISTE DES PIÈCES SONT CRITIQUES POUR LA SÉCURITÉ DE FONCTIONNEMENT. NE REMPLACER CES COMPOSANTS QUE PAR DES PIÈCES SONY DONT LES NUMÉROS SONT DONNÉS DANS CE MANUEL OU DANS LES SUPPÉMENTS PUBLIÉS PAR SONY.

CAUTION :

Danger of explosion if battery is incorrectly replaced.
Replace only with the same or equivalent type.

ÍNDICE

1. SERVICE NOTE

- 1-1. METHOD FOR COPYING OR ERASING THE DATA IN
INTERNAL MEMORY 1-1

4. PRINTED WIRING BOARDS AND SCHEMATIC DIAGRAMS

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- 5-2. ELECTRICAL PARTS LIST 5-12

1. NOTA DE SERVIÇO

1-1. MÉTODO PARA A COPIAR OU APAGAR O DADO DA MEMÓRIA INTERNA

The data can be copied/erased by the operations on the Setup screen. (When erasing the data, execute formatting the internal memory.)

Note: 1 When replacing the SY-150 board, erase the data in internal memory of the board before replacement.

Note: 2 When replacing the SY-150 board or the IC202 on the SY-150 board, execute formatting and initialize the internal memory after replacement.

Method for copying the data in internal memory

Copy

Copies all images in the internal memory to a "Memory Stick Duo".

OK	See the following procedure.
Cancel	Cancels the copying.

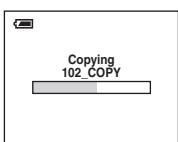
① Insert a "Memory Stick Duo" having 32 MB or larger capacity.

② Select [OK] with ▲ on the control button, then press ●.

The message "All data in internal memory will be copied Ready?" appears.

③ Select [OK] with ▲, then press ●.

Copying starts.



- Use a fully charged Nickel-Metal Hydride battery or the AC Adaptor (not supplied). If you attempt to copy image files using a batteries with little remaining charge, the batteries may run out, causing copying to fail or possibly corrupting the data.
- You cannot copy individual images.
- The original images in the internal memory are retained even after copying. To delete the contents of the internal memory, remove the "Memory Stick Duo" after copying, then execute the [Format] command in (Internal Memory Tool).
- You cannot select a folder copied on a "Memory Stick Duo".
- Even if you copy data, a (Print order) mark is not copied.

Method for formatting the internal memory

This item does not appear when a "Memory Stick Duo" is inserted in the camera.

The default settings are marked with .

Format

Formats the internal memory.

- Note that formatting irrevocably erases all data in the internal memory, including even protected images.

OK	See the following procedure.
Cancel	Cancels the formatting.

① Select [OK] with ▲ on the control button, then press ●.

The message "All data in internal memory will be erased Ready?" appears.

② Select [OK] with ▲, then press ●.

The format is complete.

• PROCESS AFTER FIXING FLASH ERROR

When "FLASH error" (Self-diagnosis Code E : 91 : **) occurs, to prevent any abnormal situation caused by high voltage, setting of the flash is changed automatically to disabling charge and flash setting.

After fixing, this setting needs to be deactivated. Flash error code can be initialized by the operations on the Setup screen.

Method for Initializing the Flash Error Code

Initialize

Initializes the setting to the default setting.

OK	See the following procedure.
Cancel	Cancels the resetting.

① Select [OK] with ▲ on the control button, then press ●.

The message "Initialize all settings Ready?" appears.

② Select [OK] with ▲, then press ●.

The settings are reset to the default setting.

Make sure that the power is not disconnected during resetting.

4-2. DIAGRAMAS ESQUEMÁTICOS

Link

• PLACA SY-150 (1/8) (LENS DRIVE)	• PLACA SY-150 (6/8) (STEADY SHOT CONTROL)
• PLACA SY-150 (2/8) (CAMERA A/D CONV., TIMING GENERATOR)	• PLACA SY-150 (7/8) (CONNECTOR)
• PLACA SY-150 (3/8) (CAMERA DSP, SYSTEM CONTROL)	• PLACA SY-150 (8/8) (DC/DC CONVERTER)
• PLACA SY-150 (4/8) (256Mbit SDRAM, BURST FLASH MEMORY, ONE NAND FLASH MEMORY)	• PLACA CH-199 (CCD SIGNAL PROCESS)
• PLACA SY-150 (5/8) (A/V AMP, A/V, USB JACK RELAY)	
• NOTA COMUM PARA DIAGRAMAS ESQUEMÁTICOS	

4-2. DIAGRAMAS ESQUEMÁTICOS

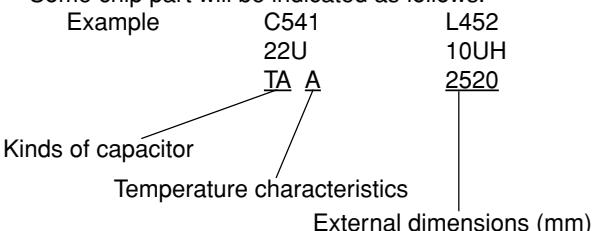
4-2. DIAGRAMAS ESQUEMÁTICOS

THIS NOTE IS COMMON FOR SCHEMATIC DIAGRAMS

(In addition to this, the necessary note is printed in each block)

(For schematic diagrams)

- All capacitors are in μ F unless otherwise noted. pF : μ F. 50 V or less are not indicated except for electrolytics and tantalums.
- Chip resistors are 1/10 W unless otherwise noted. $k\Omega=1000\ \Omega$, $M\Omega=1000\ k\Omega$.
- Caution when replacing chip parts.
New parts must be attached after removal of chip.
Be careful not to heat the minus side of tantalum capacitor, Because it is damaged by the heat.
- Some chip part will be indicated as follows.



- Constants of resistors, capacitors, ICs and etc with XX indicate that they are not used.
In such cases, the unused circuits may be indicated.
- Parts with * differ according to the model/destination.
Refer to the mount table for each function.
- All variable and adjustable resistors have characteristic curve B, unless otherwise noted.
- Signal name
XEDIT → EDIT PB/XREC → PB/REC
- : non flammable resistor
- : fusible resistor
- : panel designation
- : B+ Line
- : B- Line
- : IN/OUT direction of (+,-) B LINE.
- : adjustment for repair.

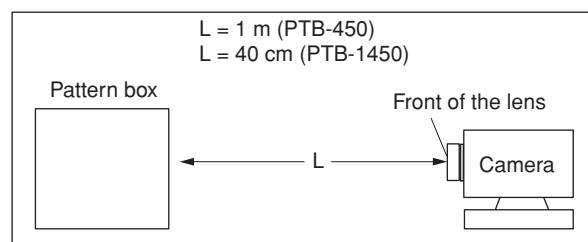
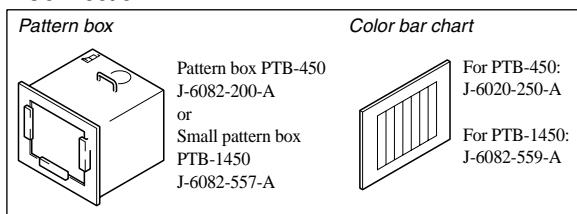
(Measuring conditions voltage)

- Voltages are measured between the measurement points and ground when camera shoots color bar chart of pattern box. They are reference values.
(VOM of DC 10 M Ω input impedance is used)
- Voltage values change depending upon input impedance of VOM used.)

Precautions for Replacement of imager

- If the imager has been replaced, carry out all the adjustments for the camera section.
- As the imager may be damaged by static electricity from its structure, handle it carefully like for the MOS IC.
In addition, ensure that the receiver is not covered with dusts nor exposed to strong light.

1. Connection



2. Adjust the distance so that the output waveform of Fig. a and the Fig. b can be obtain.

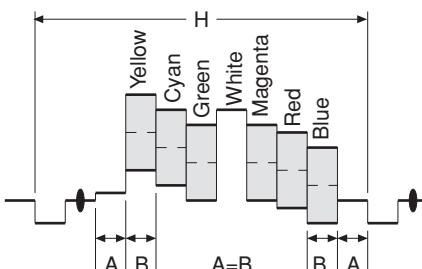


Fig. a (Video output terminal output waveform)

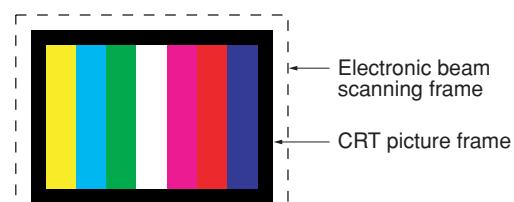


Fig.b (Picture on monitor TV)

When indicating parts by reference number, please include the board name.

Note :
The components identified by mark \triangle or dotted line with mark \triangle are critical for safety.
Replace only with part number specified.

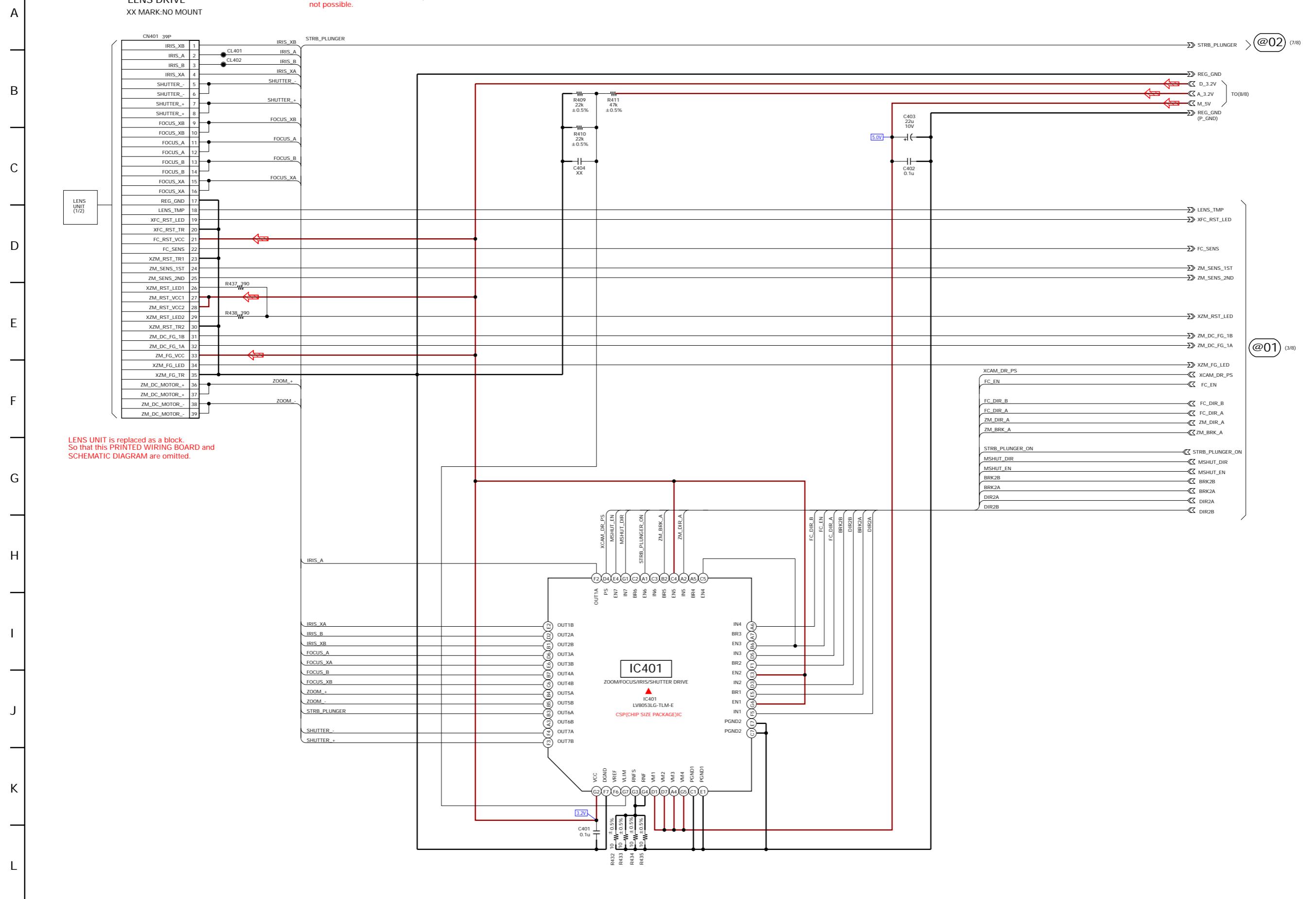
Note :
Les composants identifiés par une marque \triangle sont critiques pour la sécurité.
Ne les remplacer que par une pièce portant le numéro spécifié.

4-2. DIAGRAMAS ESQUEMÁTICOS

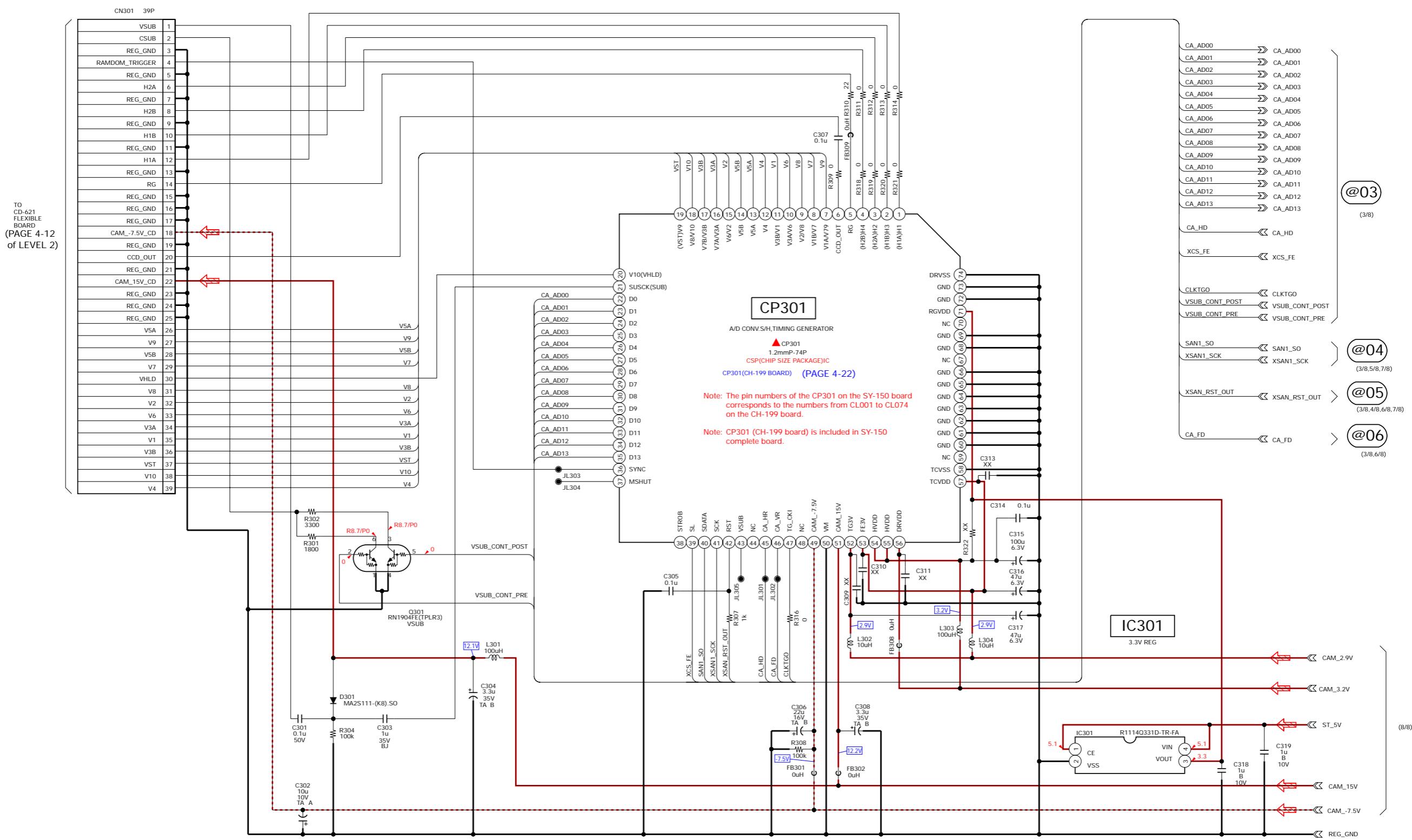
1 | 2 | 3 | 4 | 5 | 6 | 7 | 8 | 9 | 10 | 11 | 12 | 13 | 14 | 15 | 16 | 17

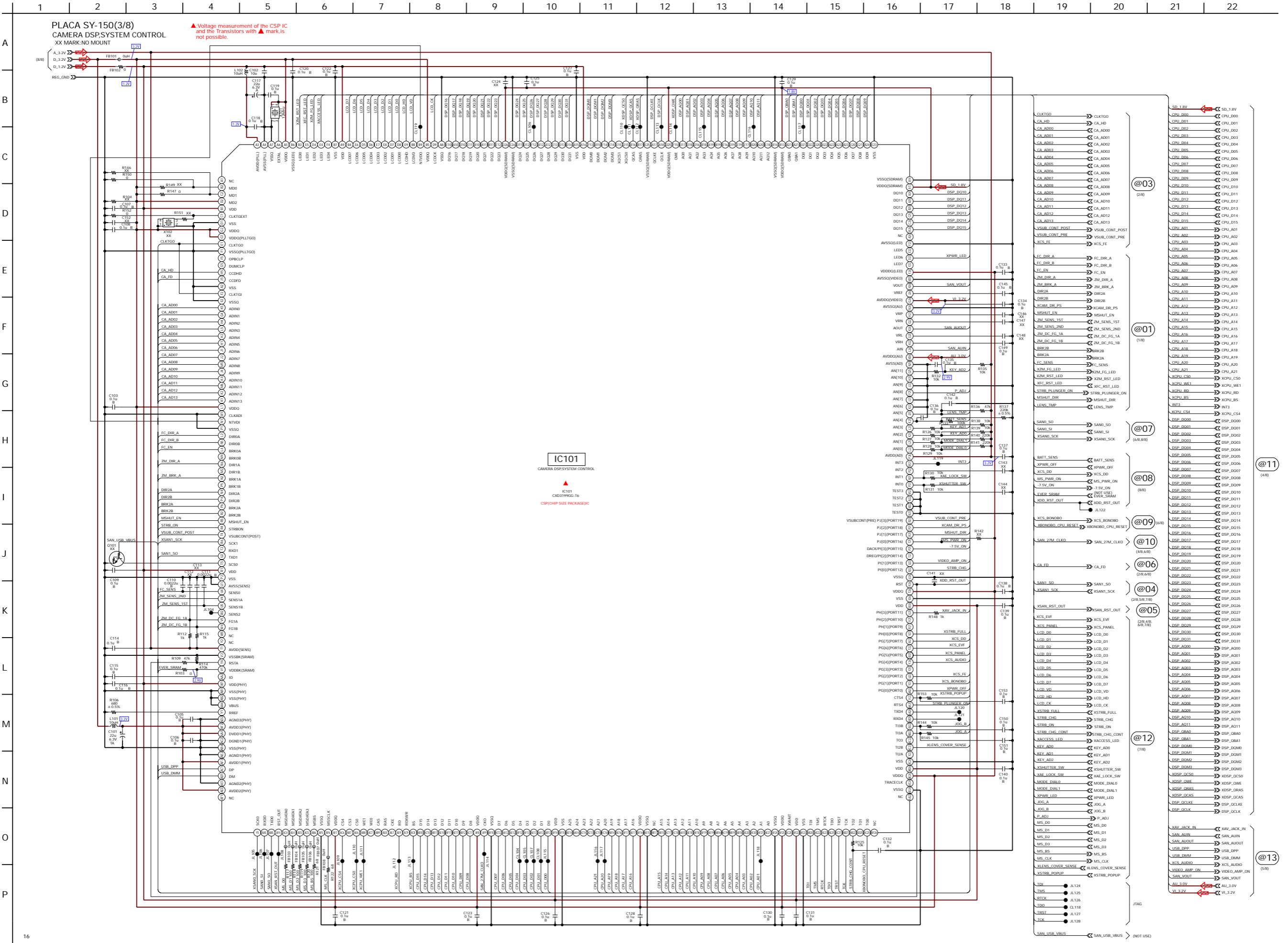
PLACA SY-150(1/8)
LENS DRIVE
XX MARK: NO MOUNT

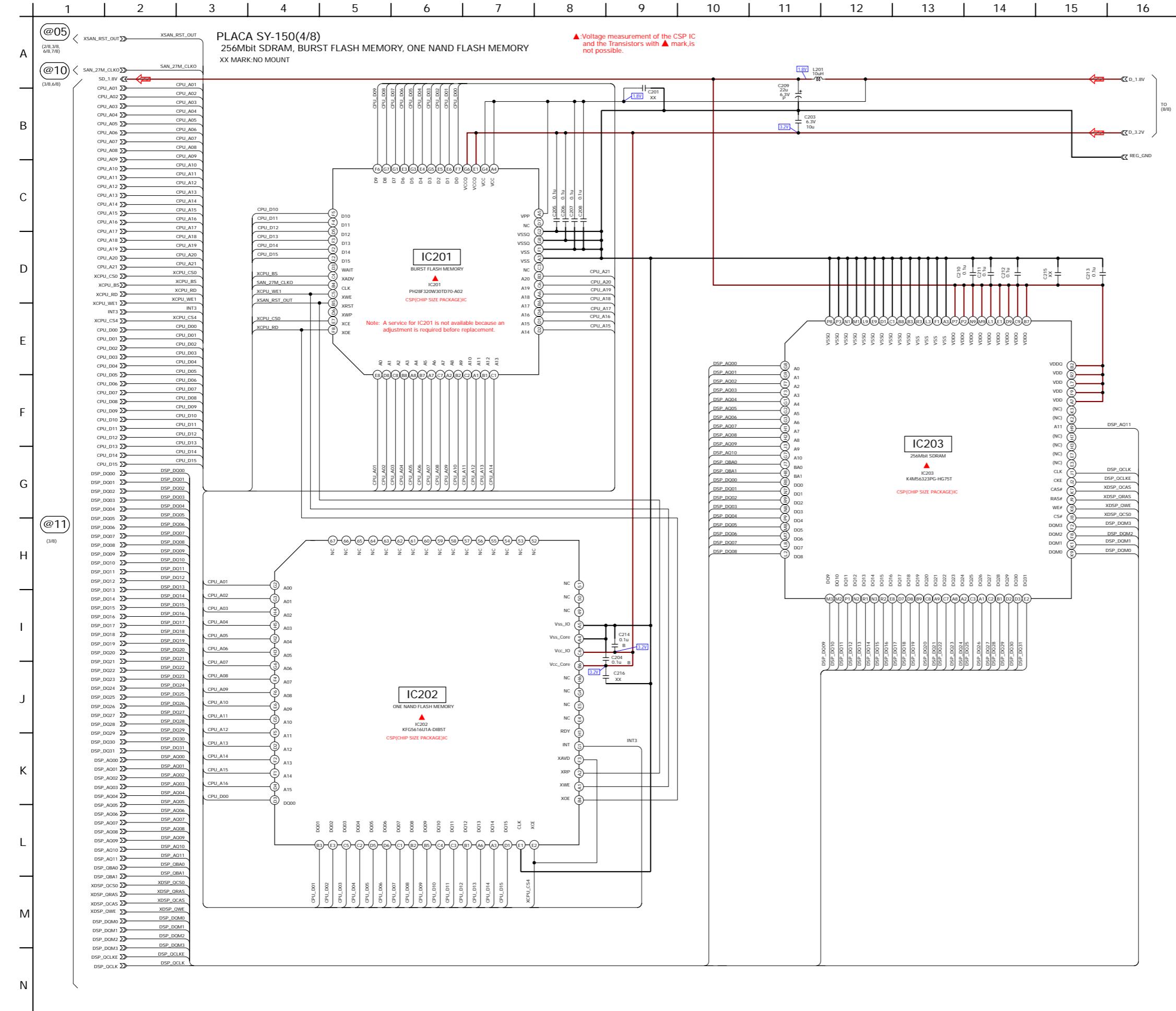
▲:Voltage measurement of the CSP IC
and the Transistors with ▲ mark,is
not possible.



PLACA SY-150(2/8)
CAMERA A/D CONV.TIMING GENERATOR
XX MARK: NO MOUNT







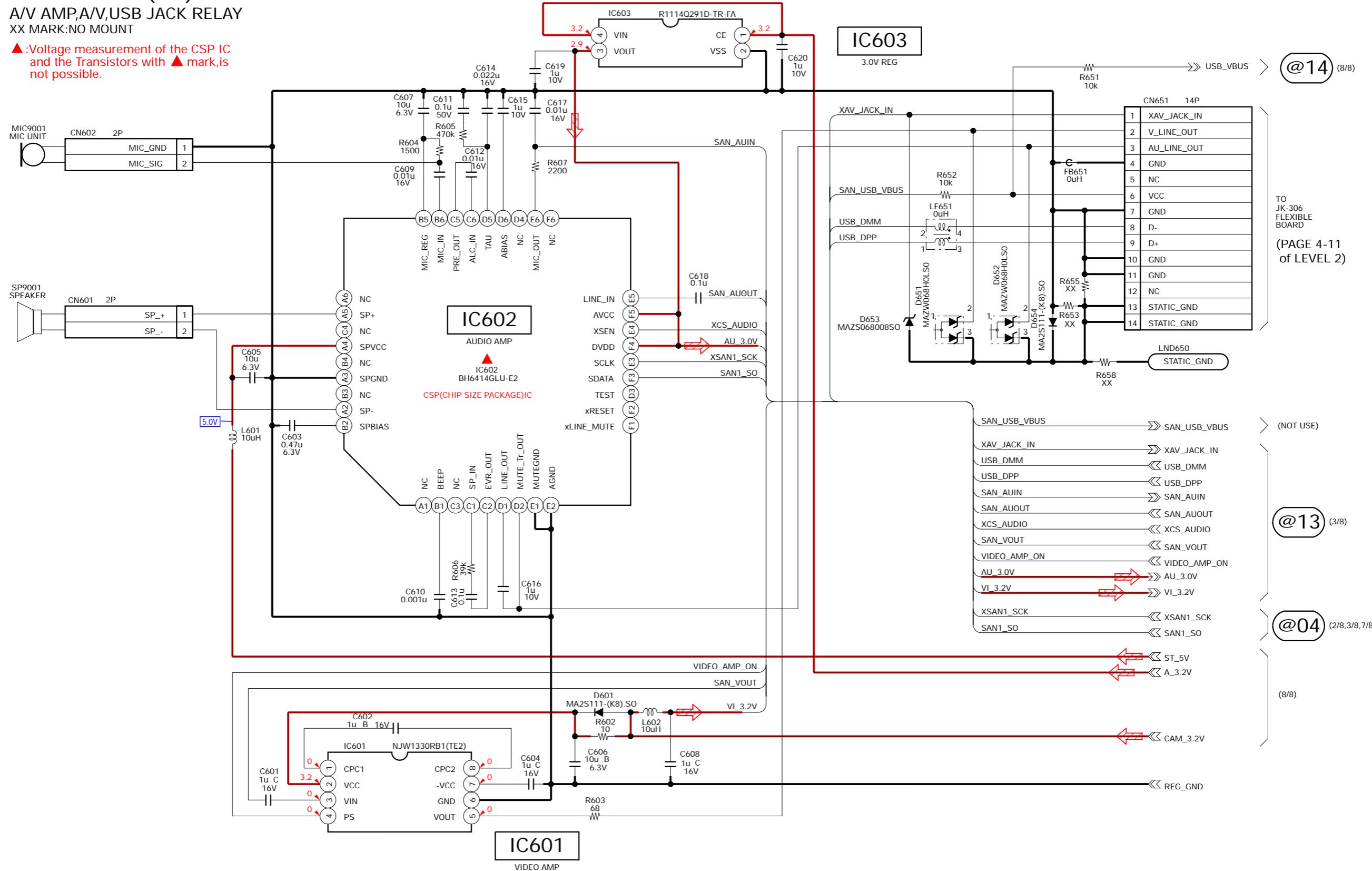
1 | 2 | 3 | 4 | 5 | 6 | 7 | 8 | 9 | 10 | 11

PLACA SY-150(5/8)

A/V AMP,A/V,USB JACK RELAY

XX MARK: NO MOUNT

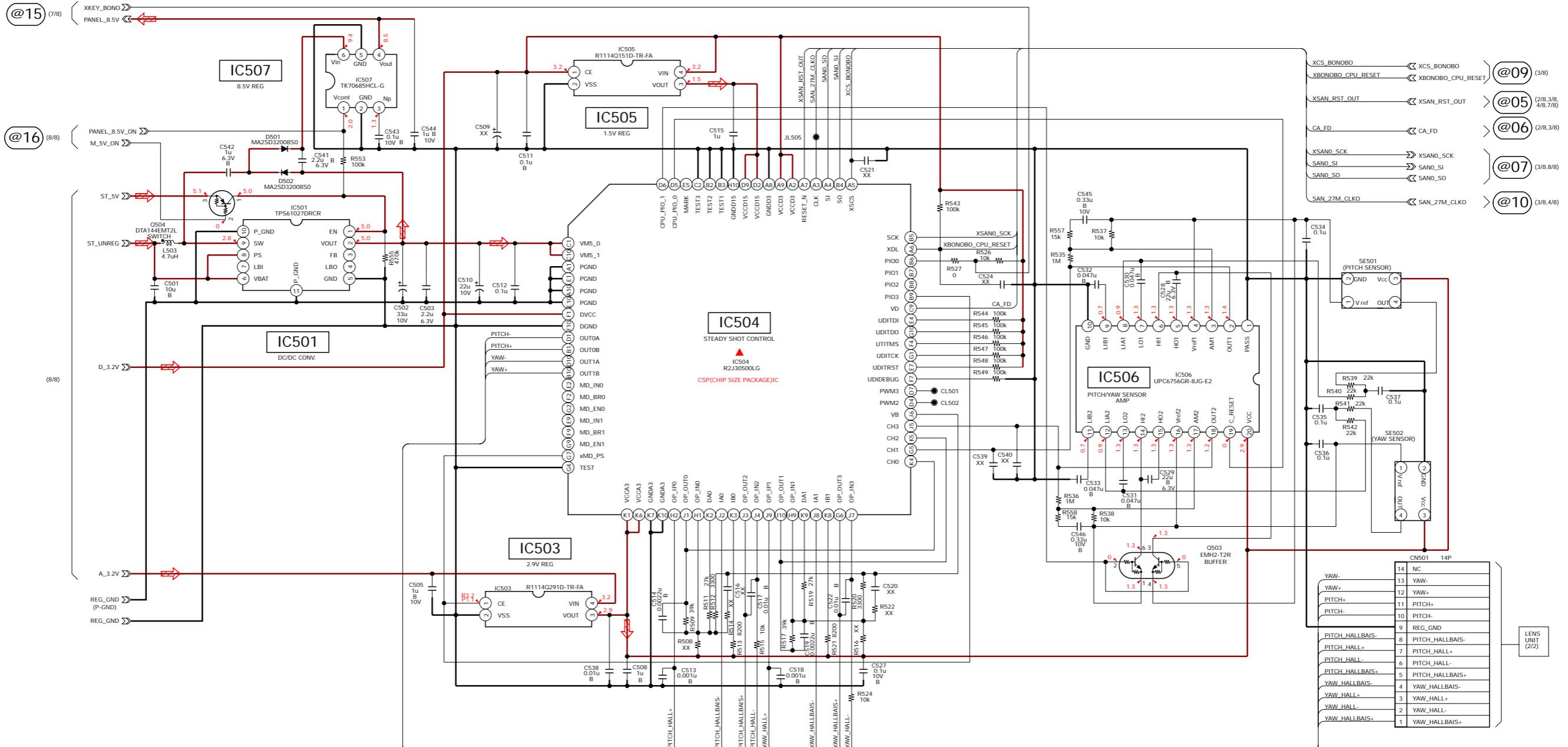
▲ : Voltage measurement of the CSP IC
and the Transistors with ▲ mark, is
not possible.



1 | 2 | 3 | 4 | 5 | 6 | 7 | 8 | 9 | 10 | 11 | 12 | 13 | 14 | 15 | 16 | 17

PLACA SY-150(6/8)
STEADY SHOT CONTROL
XX MARK: NO MOUNT

NO MARK: REC/PB MODE
R : REC MODE
P : PB MODE
▲: Voltage measurement of the CSP IC and the Transistors with ▲ mark, is not possible.



LENST UNIT is replaced as a block.
So that this PRINTED WIRING BOARD and
SCHEMATIC DIAGRAM are omitted.

1 | 2 | 3 | 4 | 5 | 6 | 7 | 8 | 9 | 10 | 11 | 12 | 13 | 14

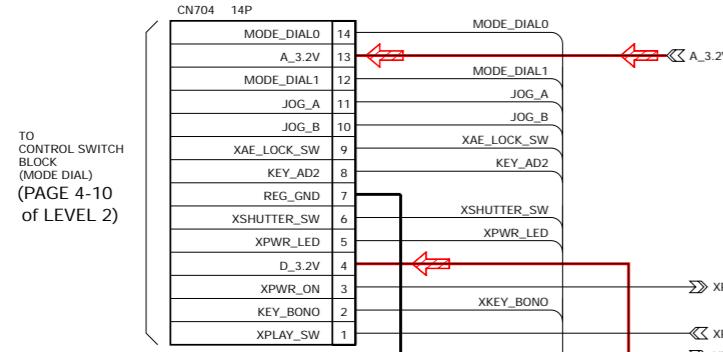
PLACA SY-150(7/8)

CONNECTOR

XX MARK: NO MOUNT

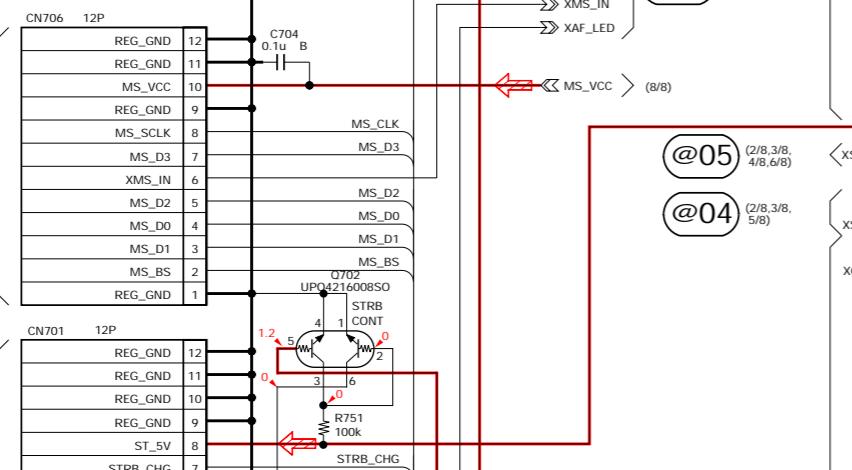
NO MARK: REC/PB MODE
R : REC MODE
P : PB MODE

A



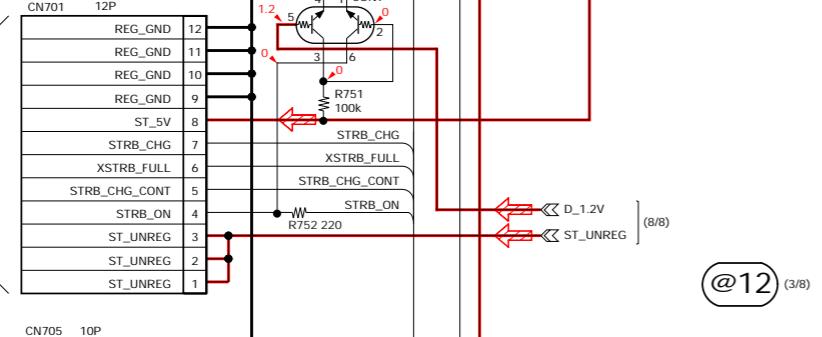
TO
CONTROL SWITCH
BLOCK
(MODE DIAL)
(PAGE 4-10
of LEVEL 2)

B



TO
MS-030
FLEXIBLE FLAT
CABLE
(PAGE 4-13
of LEVEL 2)

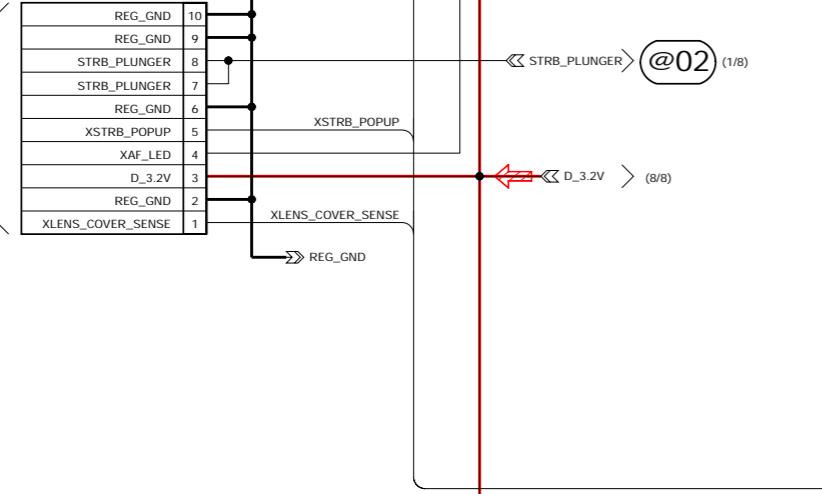
C



D

TO
ST-003
FLEXIBLE FLAT
CABLE
(PAGE 4-13
of LEVEL 2)

E



F

TO
AF-105
FLEXIBLE BOARD
(PAGE 4-11
of LEVEL 2)

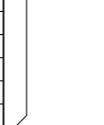
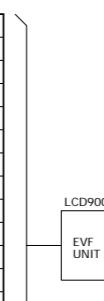
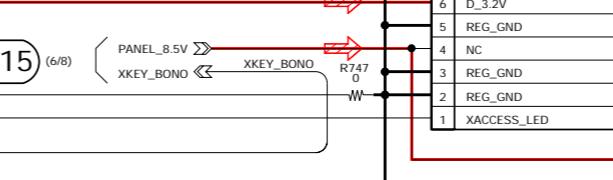
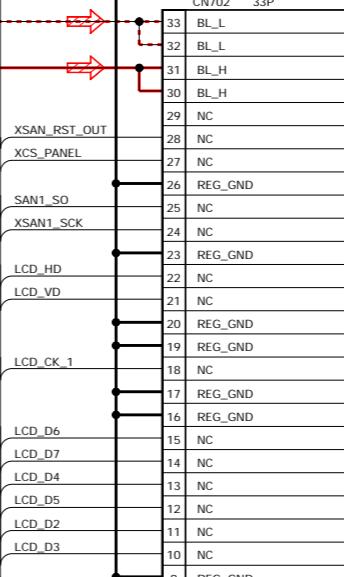
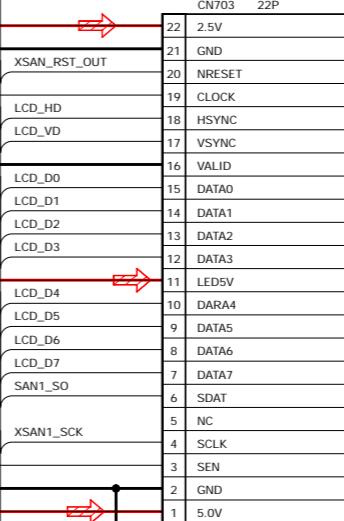
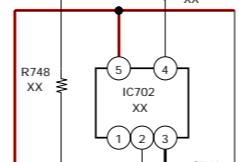
G

H

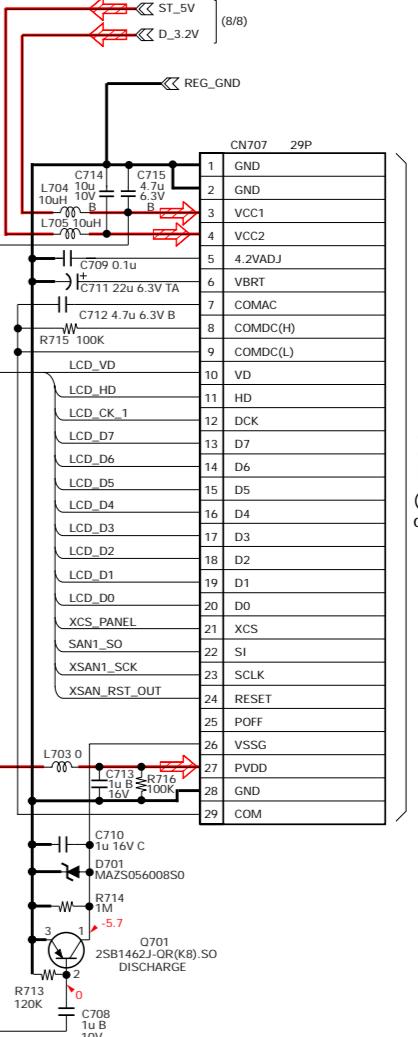
I

LCD_CK_1

EVF UNIT is replaced as a block.
So that this PRINTED WIRING BOARD and
SCHEMATIC DIAGRAM are omitted.



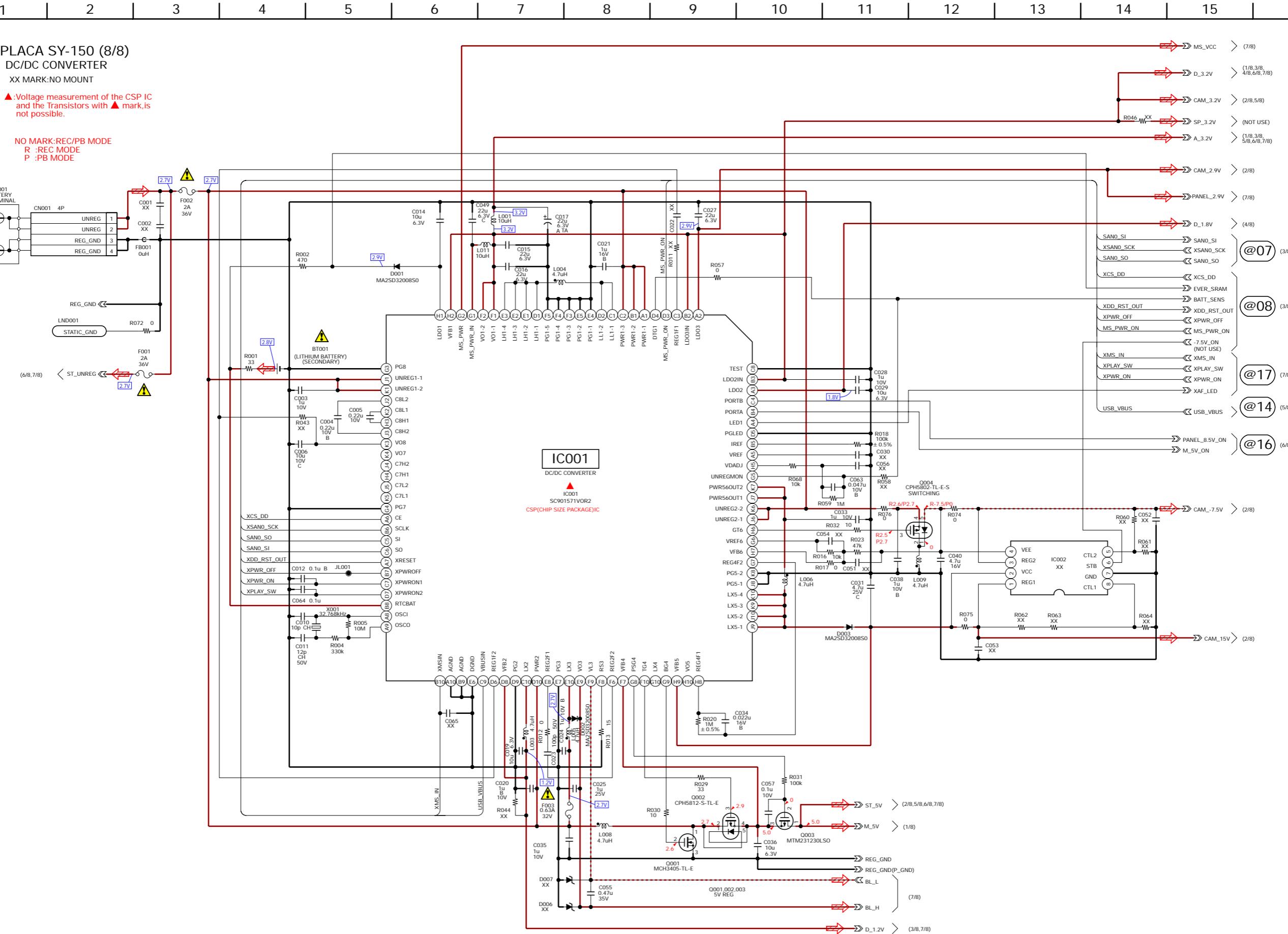
TO
SW-478
FLEXIBLE
BOARD
(PAGE 4-12
of LEVEL 2)

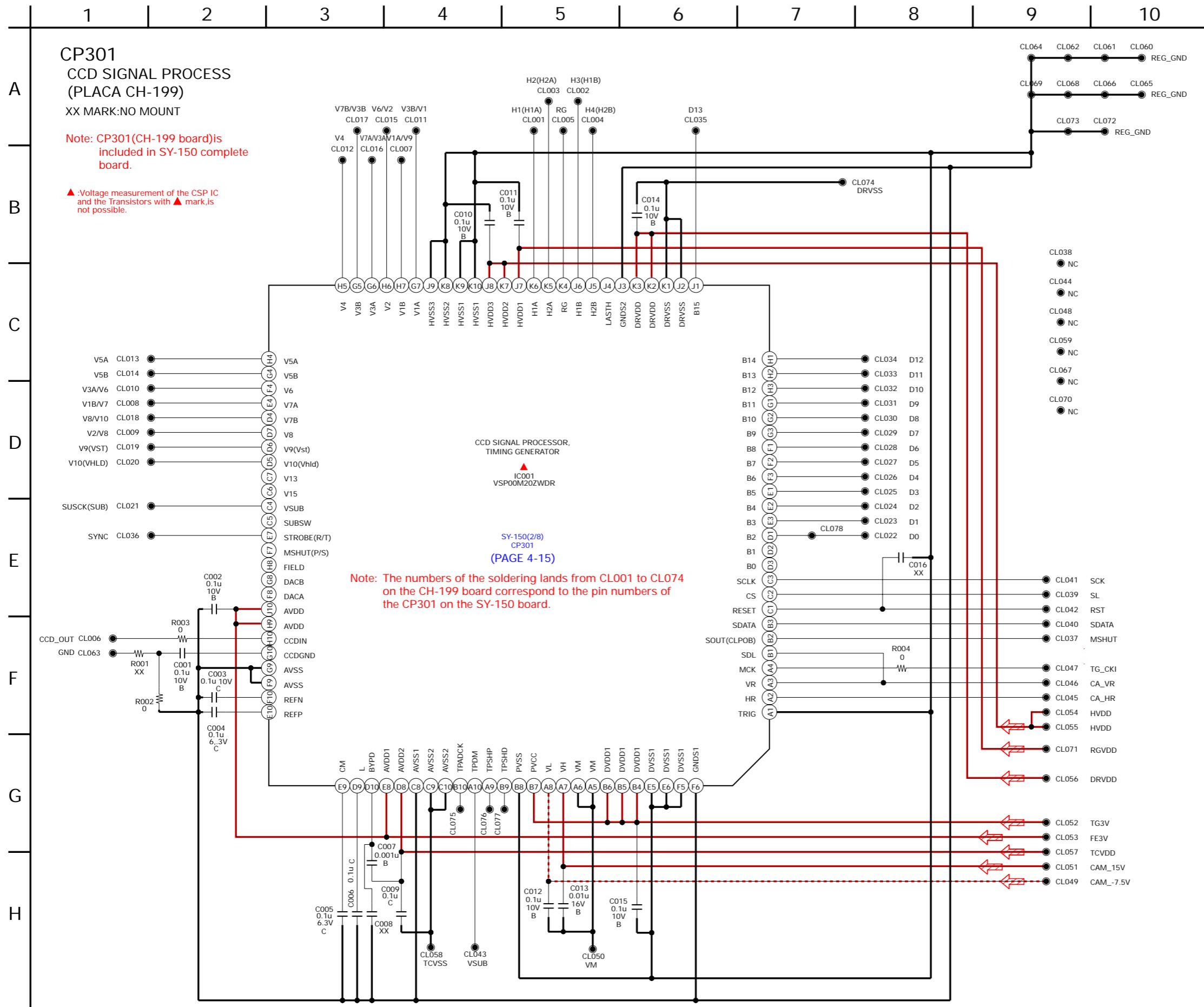


TO
CK-161
FLEXIBLE
BOARD
(PAGE 4-7
of LEVEL 2)

SY-150 (7/8)

• Refer to page 4-3 for mark △.





4-3. PLACAS DE CIRCUITO IMPRESSO

Link

• PLACA SY-150(SIDE A)

• PLACA SY-150 (SIDE B)

• PLACA CH-199

• NOTAS COMUNS PARA PLACAS DE CIRCUITO IMPRESSO

• LOCALIZAÇÃO DAS PEÇAS MONTADAS

4-3. PLACAS DE CIRCUITO IMPRESSO

4-3. PLACAS DE CIRCUITO IMPRESSO

THIS NOTE IS COMMON FOR WIRING BOARDS

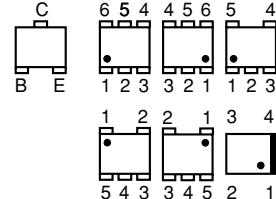
(In addition to this, the necessary note is printed in each block)

(For printed wiring boards)

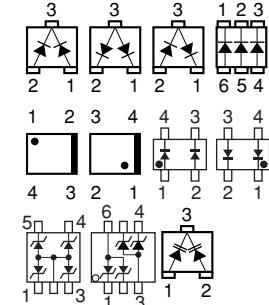
- : Uses unleaded solder.
- : Pattern from the side which enables seeing.
(The other layers' patterns are not indicated)
- Through hole is omitted.
- There are a few cases that the part printed on diagram isn't mounted in this model.
- : panel designation

- Chip parts.

Transistor



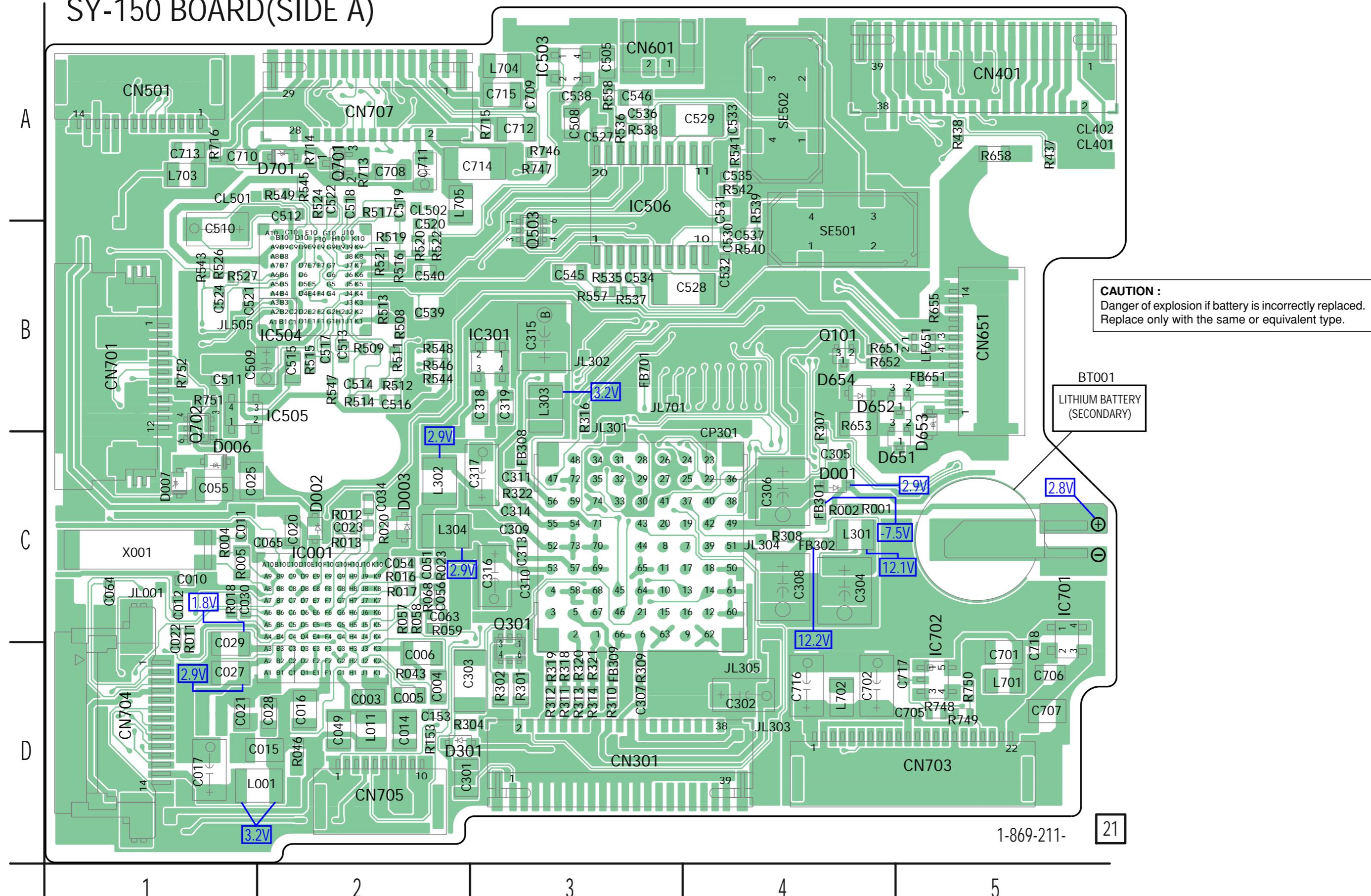
Diode



4-3. PLACAS DE CIRCUITO IMPRESSO

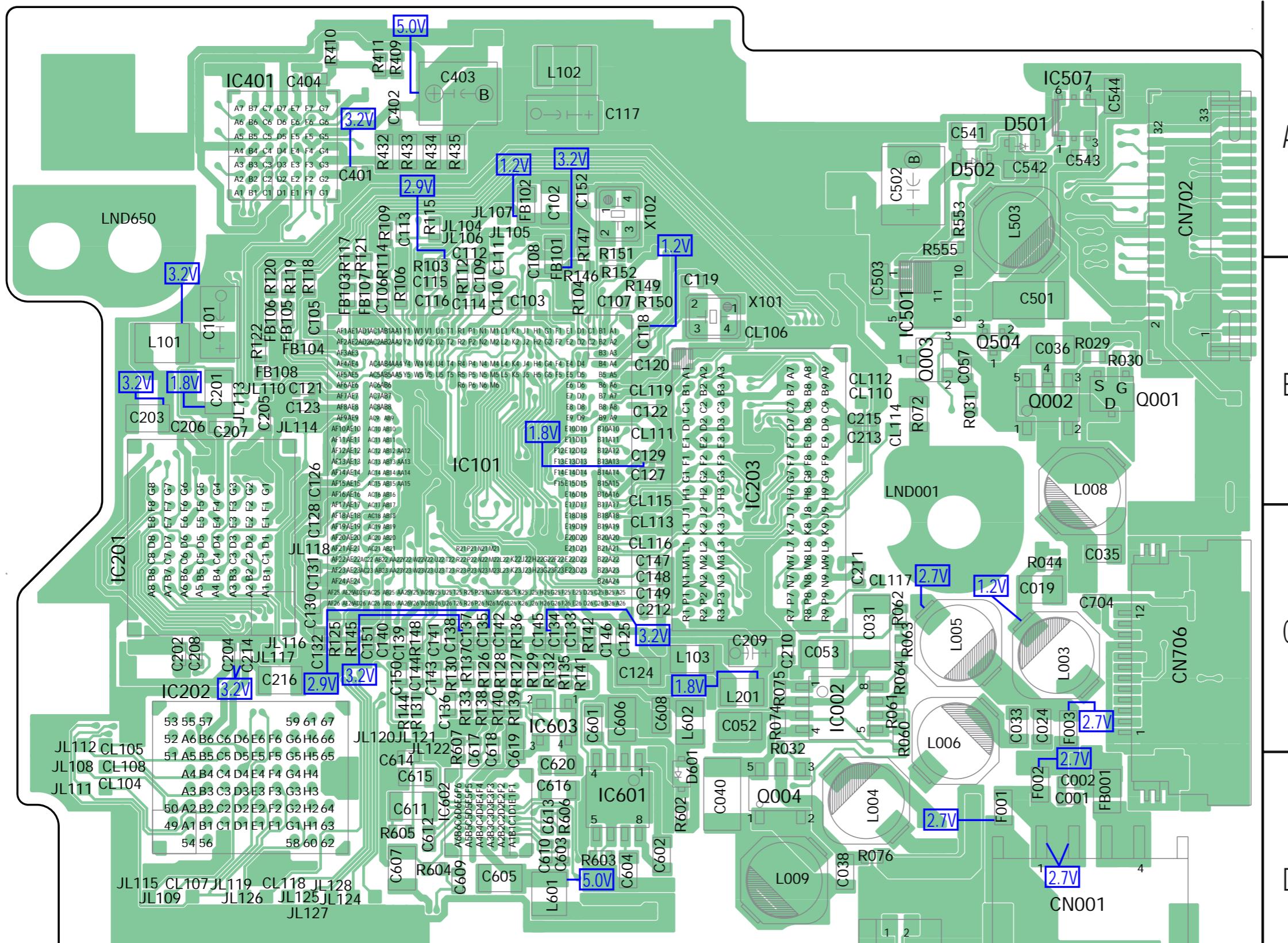
SY-150 (8 layers) •  : Uses unleaded solder.

SY-150 BOARD(SIDE A)





SY-150 BOARD(SIDE B)

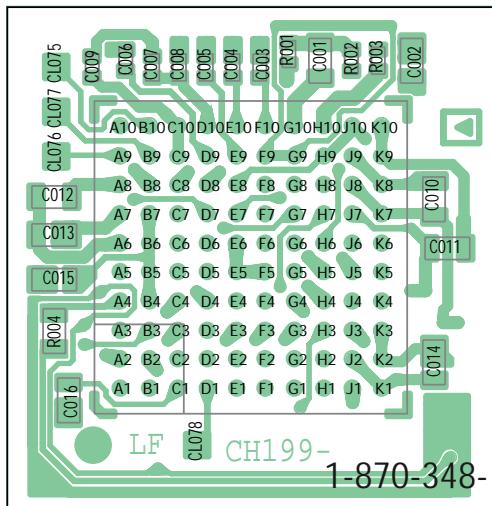


1-869-211-

21

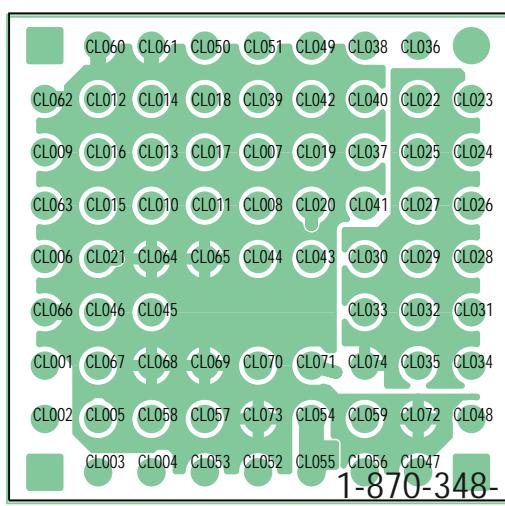
Note: CP301 (CH-199 board) is included
in SY-150 complete board.

CP301 (CH-199 board) (SIDE A)



11

(SIDE B)



11

5. LISTA DE PEÇAS PARA REPARO

NOTE:

- -XX, -X mean standardized parts, so they may have some differences from the original one.
- Items marked “*” are not stocked since they are seldom required for routine service. Some delay should be anticipated when ordering these items.
- The mechanical parts with no reference number in the exploded views are not supplied.
- Due to standardization, replacements in the parts list may be different from the parts specified in the diagrams or the components used on the set.
- CAPACITORS:
uF: μ F
- COILS
uH: μ H
- RESISTORS
All resistors are in ohms.
METAL: metal-film resistor
METAL OXIDE: Metal Oxide-film resistor
F: nonflammable
- SEMICONDUCTORS
In each case, u: μ , for example:
uA...: μ A..., uPA..., μ PA...,
uPB..., μ PB..., uPC..., μ PC...,
uPD..., μ PD...

When indicating parts by reference number,
please include the board name.

The components identified by mark \triangle or
dotted line with mark \triangle are critical for safety.
Replace only with part number specified.

Les composants identifiés par une marque
 \triangle sont critiques pour la sécurité.
Ne les remplacer que par une pièce portant
le numéro spécifié.

Language that can be selected about SY-150 board

		Area	Japanese	English	French	German	Spanish	Italian	Portugal	Simplified Chinese	Traditional Chinese	Arabic	Dutch	Russian	Swedish	Korean	Norwegian	Danish	Finnish	Polish	Hungarian	Czech	Persian	Thai	
GP1	J		●																						
GP2	US CND AUS Vietnam			●	●		●	●		●	●														
GP3	AEP UK			●	●	●	●	●	●			●	●	●		●	●	●	●	●	●				
GP4	E JE HK CH KR BR			●			●		●	●	●	●			●							●	●		

• Abbreviation

- J : Japanese model
 CND : Canadian model
 AUS : Australian model
 JE : Tourist model
 HK : Hong Kong model
 CH : Chinese model
 KR : Korea model
 BR : Brazilian model

5-2. LISTA DE PEÇAS ELÉTRICAS

Ref. No.	Part No.	Description					Ref. No.	Part No.	Description				
							C110	1-164-939-11	CERAMIC CHIP	0.0022uF	10%	50V	
		A-1176-928-A	SY-150 BOARD, COMPLETE (SERVICE)(GP4)				C111	1-164-939-11	CERAMIC CHIP	0.0022uF	10%	50V	
			*****	*****	*****		C114	1-125-777-11	CERAMIC CHIP	0.1uF	10%	10V	
		(Refer to the table of page 5-1 about language of SY-150 board.)	(This complete board is including CP301 (CH-199 board))				C115	1-125-777-11	CERAMIC CHIP	0.1uF	10%	10V	
			< COMPOSITION CIRCUIT BLOCK >				C116	1-125-777-11	CERAMIC CHIP	0.1uF	10%	10V	
CP301	A-1186-771-A	CH-199 BOARD, COMPLETE					C117	1-119-750-11	TANTAL. CHIP	22uF	20%	6.3V	
			< BATTERY >				C118	1-125-777-11	CERAMIC CHIP	0.1uF	10%	10V	
△BT001	1-756-539-21	BATTERY, LITHIUM SECONDARY					C119	1-125-777-11	CERAMIC CHIP	0.1uF	10%	10V	
			< CAPACITOR >				C120	1-125-777-11	CERAMIC CHIP	0.1uF	10%	10V	
	C003	1-165-908-11	CERAMIC CHIP	1uF	10%	10V	C121	1-125-777-11	CERAMIC CHIP	0.1uF	10%	10V	
	C004	1-115-467-11	CERAMIC CHIP	0.22uF	10%	10V	C122	1-125-777-11	CERAMIC CHIP	0.1uF	10%	10V	
	C005	1-115-467-11	CERAMIC CHIP	0.22uF	10%	10V	C123	1-125-777-11	CERAMIC CHIP	0.1uF	10%	10V	
	C006	1-100-966-91	CERAMIC CHIP	10uF	20%	10V	C125	1-125-777-11	CERAMIC CHIP	0.1uF	10%	10V	
	C010	1-164-850-11	CERAMIC CHIP	10PF	0.5PF	50V	C126	1-125-777-11	CERAMIC CHIP	0.1uF	10%	10V	
	C011	1-164-852-11	CERAMIC CHIP	12PF	5%	50V	C127	1-125-777-11	CERAMIC CHIP	0.1uF	10%	10V	
	C012	1-125-777-11	CERAMIC CHIP	0.1uF	10%	10V	C128	1-125-777-11	CERAMIC CHIP	0.1uF	10%	10V	
	C014	1-137-710-11	CERAMIC CHIP	10uF	20%	6.3V	C129	1-125-777-11	CERAMIC CHIP	0.1uF	10%	10V	
	C015	1-100-611-91	CERAMIC CHIP	22uF	20%	6.3V	C130	1-125-777-11	CERAMIC CHIP	0.1uF	10%	10V	
	C016	1-100-611-91	CERAMIC CHIP	22uF	20%	6.3V	C131	1-125-777-11	CERAMIC CHIP	0.1uF	10%	10V	
	C017	1-119-750-11	TANTAL. CHIP	22uF	20%	6.3V	C132	1-125-777-11	CERAMIC CHIP	0.1uF	10%	10V	
	C019	1-137-710-11	CERAMIC CHIP	10uF	20%	6.3V	C133	1-125-777-11	CERAMIC CHIP	0.1uF	10%	10V	
*	C020	1-165-908-11	CERAMIC CHIP	1uF	10%	10V	C134	1-125-777-11	CERAMIC CHIP	0.1uF	10%	10V	
* C021	1-112-298-91	CERAMIC CHIP	1uF	10%	16V	C135	1-125-777-11	CERAMIC CHIP	0.1uF	10%	10V		
	C023	1-164-874-11	CERAMIC CHIP	100PF	5%	50V	C136	1-125-777-11	CERAMIC CHIP	0.1uF	10%	10V	
	C024	1-165-908-11	CERAMIC CHIP	1uF	10%	10V	C137	1-125-777-11	CERAMIC CHIP	0.1uF	10%	10V	
	C025	1-100-591-91	CERAMIC CHIP	1uF	10%	25V	C138	1-125-777-11	CERAMIC CHIP	0.1uF	10%	10V	
	C027	1-100-611-91	CERAMIC CHIP	22uF	20%	6.3V	C139	1-125-777-11	CERAMIC CHIP	0.1uF	10%	10V	
	C028	1-165-908-11	CERAMIC CHIP	1uF	10%	10V	C140	1-125-777-11	CERAMIC CHIP	0.1uF	10%	10V	
	C029	1-137-710-11	CERAMIC CHIP	10uF	20%	6.3V	C142	1-125-777-11	CERAMIC CHIP	0.1uF	10%	10V	
	C031	1-100-671-11	CERAMIC CHIP	4.7uF	20%	25V	C145	1-125-777-11	CERAMIC CHIP	0.1uF	10%	10V	
	C033	1-165-908-11	CERAMIC CHIP	1uF	10%	10V	C149	1-125-777-11	CERAMIC CHIP	0.1uF	10%	10V	
	C034	1-107-819-11	CERAMIC CHIP	0.022uF	10%	16V	C150	1-125-777-11	CERAMIC CHIP	0.1uF	10%	10V	
	C035	1-165-908-11	CERAMIC CHIP	1uF	10%	10V	C151	1-125-777-11	CERAMIC CHIP	0.1uF	10%	10V	
	C036	1-137-710-11	CERAMIC CHIP	10uF	20%	6.3V	C153	1-125-777-11	CERAMIC CHIP	0.1uF	10%	10V	
	C038	1-165-908-11	CERAMIC CHIP	1uF	10%	10V	C203	1-137-710-11	CERAMIC CHIP	10uF	20%	6.3V	
	C040	1-127-820-11	CERAMIC CHIP	4.7uF	10%	16V	C204	1-125-777-11	CERAMIC CHIP	0.1uF	10%	10V	
	C049	1-100-611-91	CERAMIC CHIP	22uF	20%	6.3V	C205	1-125-777-11	CERAMIC CHIP	0.1uF	10%	10V	
	C055	1-100-565-91	CERAMIC CHIP	0.47uF	10%	35V	C206	1-125-777-11	CERAMIC CHIP	0.1uF	10%	10V	
	C057	1-125-777-11	CERAMIC CHIP	0.1uF	10%	10V	C207	1-125-777-11	CERAMIC CHIP	0.1uF	10%	10V	
	C063	1-119-923-11	CERAMIC CHIP	0.047uF	10%	10V	C208	1-125-777-11	CERAMIC CHIP	0.1uF	10%	10V	
	C064	1-125-777-11	CERAMIC CHIP	0.1uF	10%	10V	C214	1-125-777-11	CERAMIC CHIP	0.1uF	10%	10V	
	C101	1-119-750-11	TANTAL. CHIP	22uF	20%	6.3V	C301	1-115-339-11	CERAMIC CHIP	0.1uF	10%	50V	
	C102	1-137-710-11	CERAMIC CHIP	10uF	20%	6.3V	C302	1-104-851-11	TANTAL. CHIP	10uF	20%	10V	
	C103	1-125-777-11	CERAMIC CHIP	0.1uF	10%	10V	C303	1-137-988-91	CERAMIC CHIP	1uF	10%	35V	
	C105	1-125-777-11	CERAMIC CHIP	0.1uF	10%	10V	C304	1-113-992-11	TANTAL. CHIP	3.3uF	20%	35V	
	C106	1-125-777-11	CERAMIC CHIP	0.1uF	10%	10V	C305	1-125-777-11	CERAMIC CHIP	0.1uF	10%	10V	
	C107	1-125-777-11	CERAMIC CHIP	0.1uF	10%	10V	C306	1-119-751-11	TANTAL. CHIP	22uF	20%	16V	
	C108	1-125-777-11	CERAMIC CHIP	0.1uF	10%	10V	C307	1-100-505-91	CERAMIC CHIP	0.1uF	20%	16V	
	C109	1-125-777-11	CERAMIC CHIP	0.1uF	10%	10V	C308	1-113-992-11	TANTAL. CHIP	3.3uF	20%	35V	
							C314	1-125-777-11	CERAMIC CHIP	0.1uF	10%	10V	

Ref. No.	Part No.	Description				Ref. No.	Part No.	Description			
C315	1-128-964-91	TANTAL. CHIP	100uF	20%	6.3V	C620	1-165-908-11	CERAMIC CHIP	1uF	10%	10V
C316	1-100-539-91	TANTAL. CHIP	47uF	20%	6.3V	C701	1-100-611-91	CERAMIC CHIP	22uF	20%	6.3V
C317	1-100-539-91	TANTAL. CHIP	47uF	20%	6.3V	C704	1-125-777-11	CERAMIC CHIP	0.1uF	10%	10V
C318	1-165-908-11	CERAMIC CHIP	1uF	10%	10V	C705	1-164-943-81	CERAMIC CHIP	0.01uF	10%	16V
C319	1-165-908-11	CERAMIC CHIP	1uF	10%	10V	C706	1-107-826-11	CERAMIC CHIP	0.1uF	10%	16V
C401	1-125-777-11	CERAMIC CHIP	0.1uF	10%	10V	C707	1-137-710-11	CERAMIC CHIP	10uF	20%	6.3V
C402	1-125-777-11	CERAMIC CHIP	0.1uF	10%	10V	C708	1-165-908-11	CERAMIC CHIP	1uF	10%	10V
C403	1-100-663-11	TANTAL. CHIP	22uF	20%	10V	C709	1-125-777-11	CERAMIC CHIP	0.1uF	10%	10V
C501	1-165-875-11	CERAMIC CHIP	10uF	10%	10V	C710	1-100-352-91	CERAMIC CHIP	1uF	20%	16V
C502	1-135-993-11	TANTAL. CHIP	33uF	20%	10V	C711	1-100-786-91	TANTAL. CHIP	22uF	20%	6.3V
C503	1-165-884-91	CERAMIC CHIP	2.2uF	10%	6.3V	C712	1-127-760-11	CERAMIC CHIP	4.7uF	10%	6.3V
C505	1-165-908-11	CERAMIC CHIP	1uF	10%	10V	C713	1-100-352-91	CERAMIC CHIP	1uF	20%	16V
C508	1-165-908-11	CERAMIC CHIP	1uF	10%	10V	C714	1-165-875-11	CERAMIC CHIP	10uF	10%	10V
C510	1-165-897-11	TANTAL. CHIP	22uF	20%	10V	C715	1-127-760-11	CERAMIC CHIP	4.7uF	10%	6.3V
C511	1-125-777-11	CERAMIC CHIP	0.1uF	10%	10V	C716	1-165-897-11	TANTAL. CHIP	22uF	20%	10V
C512	1-125-777-11	CERAMIC CHIP	0.1uF	10%	10V			< CONNECTOR >			
C513	1-164-937-11	CERAMIC CHIP	0.001uF	10%	50V	CN001	1-580-057-11	PIN, CONNECTOR (SMD) 4P			
C514	1-164-939-11	CERAMIC CHIP	0.0022uF	10%	50V	* CN301	1-816-057-51	CONNECTOR, FPC (ZIF) 39P			
C515	1-165-908-11	CERAMIC CHIP	1uF	10%	10V	* CN401	1-816-057-51	CONNECTOR, FPC (ZIF) 39P			
C517	1-164-943-81	CERAMIC CHIP	0.01uF	10%	16V	* CN501	1-816-645-51	FFC/FPC CONNECTOR (LIF) 14P			
C518	1-164-937-11	CERAMIC CHIP	0.001uF	10%	50V	CN601	1-794-375-21	PIN, CONNECTOR 2P			
C519	1-164-939-11	CERAMIC CHIP	0.0022uF	10%	50V	CN602	1-794-375-21	PIN, CONNECTOR 2P			
C522	1-164-943-81	CERAMIC CHIP	0.01uF	10%	16V	* CN651	1-816-645-51	FFC/FPC CONNECTOR (LIF) 14P			
C527	1-125-777-11	CERAMIC CHIP	0.1uF	10%	10V	CN701	1-819-254-51	CONNECTOR, FFC/FPC (ZIF) 12P			
C528	1-100-159-91	CERAMIC CHIP	22uF	10%	6.3V	* CN702	1-815-333-51	CONNECTOR, FPC (ZIF) 33P			
C529	1-100-159-91	CERAMIC CHIP	22uF	10%	6.3V	* CN703	1-816-649-51	FFC/FPC CONNECTOR (LIF) 22P			
C530	1-119-923-11	CERAMIC CHIP	0.047uF	10%	10V			< DIODE >			
C531	1-119-923-11	CERAMIC CHIP	0.047uF	10%	10V	D001	6-500-813-01	DIODE MA2SD32008S0			
C532	1-119-923-11	CERAMIC CHIP	0.047uF	10%	10V	D002	6-500-813-01	DIODE MA2SD32008S0			
C533	1-119-923-11	CERAMIC CHIP	0.047uF	10%	10V	D003	6-500-813-01	DIODE MA2SD32008S0			
C534	1-125-777-11	CERAMIC CHIP	0.1uF	10%	10V	D301	8-719-056-23	DIODE MA2S111-(K8).SO			
C535	1-125-777-11	CERAMIC CHIP	0.1uF	10%	10V	D501	6-500-813-01	DIODE MA2SD32008S0			
C536	1-125-777-11	CERAMIC CHIP	0.1uF	10%	10V	D502	6-500-813-01	DIODE MA2SD32008S0			
C537	1-125-777-11	CERAMIC CHIP	0.1uF	10%	10V	D601	8-719-056-23	DIODE MA2S111-(K8).SO			
C538	1-164-943-81	CERAMIC CHIP	0.01uF	10%	16V	D651	6-500-776-01	DIODE MAZW068H0LS0			
C541	1-165-884-91	CERAMIC CHIP	2.2uF	10%	6.3V	D652	6-500-776-01	DIODE MAZW068H0LS0			
C542	1-125-837-91	CERAMIC CHIP	1uF	10%	6.3V	D653	8-719-056-54	DIODE MAZS068008SO			
C543	1-125-777-11	CERAMIC CHIP	0.1uF	10%	10V	D654	8-719-056-23	DIODE MA2S111-(K8).SO			
C544	1-165-908-11	CERAMIC CHIP	1uF	10%	10V	D701	6-500-941-01	DIODE MAZS056008SO			
C545	1-128-934-61	CERAMIC CHIP	0.33uF	10%	10V			< FUSE >			
C546	1-128-934-61	CERAMIC CHIP	0.33uF	10%	10V	F001	1-576-416-21	FUSE 2A/36V			
C601	1-100-352-91	CERAMIC CHIP	1uF	20%	16V	F002	1-576-416-21	FUSE 2A/36V			
C602	1-100-352-91	CERAMIC CHIP	1uF	20%	16V	F003	1-576-570-21	FUSE, MICRO (1608 TYPE) 0.63A/32V			
C605	1-137-710-11	CERAMIC CHIP	10uF	20%	6.3V			< FERRITE BEAD >			
C606	1-137-710-11	CERAMIC CHIP	10uF	20%	6.3V	FB001	1-469-324-21	INDUCTOR (EMI FERRITE) (2012)			
C607	1-137-710-11	CERAMIC CHIP	10uF	20%	6.3V	FB101	1-500-284-21	INDUCTOR, FERRITE BEAD			
C608	1-100-352-91	CERAMIC CHIP	1uF	20%	16V	FB102	1-216-864-11	SHORT CHIP O (Note1)			
C609	1-164-943-81	CERAMIC CHIP	0.01uF	10%	16V	FB103	1-469-581-21	INDUCTOR, FERRITE BEAD (1005)			
C610	1-164-937-11	CERAMIC CHIP	0.001uF	10%	50V	FB104	1-469-581-21	INDUCTOR, FERRITE BEAD (1005)			
C611	1-115-339-11	CERAMIC CHIP	0.1uF	10%	50V						
C612	1-164-943-81	CERAMIC CHIP	0.01uF	10%	16V						
C613	1-125-777-11	CERAMIC CHIP	0.1uF	10%	10V						
C614	1-107-819-11	CERAMIC CHIP	0.022uF	10%	16V						
C615	1-165-908-11	CERAMIC CHIP	1uF	10%	10V						
C616	1-165-908-11	CERAMIC CHIP	1uF	10%	10V						
C617	1-164-943-81	CERAMIC CHIP	0.01uF	10%	16V						
C618	1-125-777-11	CERAMIC CHIP	0.1uF	10%	10V						
C619	1-165-908-11	CERAMIC CHIP	1uF	10%	10V						

Note 1:
SHORT CHIP is mounted to the location where FB102 is printed.

Ref. No.	Part No.	Description	Ref. No.	Part No.	Description
FB105	1-469-581-21	INDUCTOR, FERRITE BEAD (1005)			< LINE FILTER >
FB106	1-469-581-21	INDUCTOR, FERRITE BEAD (1005)	LF651	1-456-583-11	COMMON MODE CHOKE COIL
FB107	1-469-581-21	INDUCTOR, FERRITE BEAD (1005)			< TRANSISTOR >
FB108	1-469-581-21	INDUCTOR, FERRITE BEAD (1005)			
FB301	1-469-082-21	INDUCTOR, FERRITE BEAD (1005)	Q001	8-729-056-01	TRANSISTOR MCH3405-TL-E
FB302	1-469-082-21	INDUCTOR, FERRITE BEAD (1005)	Q002	6-550-351-01	TRANSISTOR CPH5812-S-TL-E
FB308	1-400-331-11	FERRITE, EMI (SMD) (1005)	Q003	6-551-304-01	TRANSISTOR MTM231230LSO
FB309	1-400-620-21	INDUCTOR, FERRITE BEAD (1005)	Q004	8-729-053-76	TRANSISTOR CPH5802-TL-E-S
FB651	1-469-580-11	INDUCTOR, FERRITE BEAD (1005)	Q301	8-729-053-58	TRANSISTOR RN1904FE (TPLR3)
FB701	1-469-580-11	INDUCTOR, FERRITE BEAD (1005)	Q503	6-550-094-01	TRANSISTOR EMH2-T2R
		< IC >	Q504	6-550-239-01	TRANSISTOR DTA144EMT2L
* IC001	6-709-120-01	IC SC901571V0R2	Q701	8-729-042-26	TRANSISTOR 2SB1462J-QR (K8).SO
* IC101	8-753-251-12	IC CXD3199GG-T6	Q702	8-729-054-52	TRANSISTOR UP04216008S0
* IC201	Not supplied	IC PH28F320W30TD70-A02 (Note1)			< RESISTOR >
* IC202	6-709-151-01	IC KFG5616U1A-DIB5T	R001	1-218-935-11	RES-CHIP 33 5% 1/16W
* IC203	6-708-803-01	IC K4M56323PG-HG75T	R002	1-218-949-11	RES-CHIP 470 5% 1/16W
IC301	6-703-977-01	IC R1114Q331D-TR-FA	R004	1-218-983-11	RES-CHIP 330K 5% 1/16W
IC401	6-708-988-01	IC LV8053LG-TLM-E	R005	1-219-570-11	METAL CHIP 10M 5% 1/10W
IC501	6-707-643-01	IC TPS61027DRCR	R012	1-218-990-81	SHORT CHIP 0
* IC503	6-708-445-01	IC R1114Q291D-TR-FA	R013	1-220-874-81	METAL CHIP 15 0.5% 1/16W
* IC504	6-709-026-01	IC R2J30500LG	R016	1-208-911-11	METAL CHIP 10K 0.5% 1/16W
* IC505	6-708-457-01	IC R1114Q151D-TR-FA	R017	1-218-990-81	SHORT CHIP 0
IC506	8-759-489-19	IC uPC6756GR-8JG-E2	R018	1-208-935-11	METAL CHIP 100K 0.5% 1/16W
* IC507	6-709-332-01	IC TK70685HCL-G	R020	1-218-989-11	RES-CHIP 1M 5% 1/16W
* IC601	6-708-096-01	IC NJW1330RB1 (TE2)	R023	1-208-927-11	METAL CHIP 47K 0.5% 1/16W
IC602	6-707-336-01	IC BH6414GLU-E2	R029	1-218-935-11	RES-CHIP 33 5% 1/16W
* IC603	6-708-445-01	IC R1114Q291D-TR-FA	R030	1-218-929-11	RES-CHIP 10 5% 1/16W
* IC701	6-708-464-01	IC R1114Q251D-TR-FA	R031	1-218-977-11	RES-CHIP 100K 5% 1/16W
		< COIL >	R032	1-218-929-11	RES-CHIP 10 5% 1/16W
L001	1-469-967-21	INDUCTOR 10uH	R057	1-218-990-81	SHORT CHIP 0
L003	1-456-995-22	INDUCTOR 4.7uH	R059	1-218-989-11	RES-CHIP 1M 5% 1/16W
L004	1-456-995-22	INDUCTOR 4.7uH	R068	1-218-965-11	RES-CHIP 10K 5% 1/16W
L005	1-456-995-22	INDUCTOR 4.7uH	R072	1-216-864-11	SHORT CHIP 0
L006	1-456-995-22	INDUCTOR 4.7uH	R074	1-218-990-81	SHORT CHIP 0
L008	1-456-995-22	INDUCTOR 4.7uH	R075	1-218-990-81	SHORT CHIP 0
L009	1-456-995-22	INDUCTOR 4.7uH	R076	1-218-990-81	SHORT CHIP 0
L011	1-469-555-21	INDUCTOR 10uH	R103	1-218-990-81	SHORT CHIP 0
L101	1-469-967-21	INDUCTOR 10uH	R106	1-208-679-11	METAL CHIP 680 0.5% 1/16W
L102	1-469-967-21	INDUCTOR 10uH	R109	1-218-973-11	RES-CHIP 47K 5% 1/16W
L201	1-400-588-11	INDUCTOR 10uH	R112	1-208-683-11	METAL CHIP 1K 0.5% 1/16W
L301	1-469-561-21	INDUCTOR 100uH	R114	1-218-985-11	RES-CHIP 470K 5% 1/16W
L302	1-469-967-21	INDUCTOR 10uH	R115	1-208-683-11	METAL CHIP 1K 0.5% 1/16W
L303	1-400-317-21	INDUCTOR 100uH	R117	1-218-941-81	RES-CHIP 100 5% 1/16W
L304	1-469-967-21	INDUCTOR 10uH	R118	1-218-941-81	RES-CHIP 100 5% 1/16W
L503	1-456-995-22	INDUCTOR 4.7uH	R119	1-218-941-81	RES-CHIP 100 5% 1/16W
L601	1-469-555-21	INDUCTOR 10uH	R120	1-218-941-81	RES-CHIP 100 5% 1/16W
L602	1-400-588-11	INDUCTOR 10uH	R121	1-218-939-11	RES-CHIP 68 5% 1/16W
L701	1-216-295-91	SHORT CHIP 0 (Note2)	R122	1-218-939-11	RES-CHIP 68 5% 1/16W
L702	1-412-006-31	INDUCTOR 10uH	R125	1-218-965-11	RES-CHIP 10K 5% 1/16W
L703	1-216-295-91	SHORT CHIP 0 (Note2)	R126	1-218-965-11	RES-CHIP 10K 5% 1/16W
L704	1-400-588-11	INDUCTOR 10uH	R127	1-218-965-11	RES-CHIP 10K 5% 1/16W
L705	1-400-588-11	INDUCTOR 10uH	R128	1-218-965-11	RES-CHIP 10K 5% 1/16W
			R129	1-218-965-11	RES-CHIP 10K 5% 1/16W
			R130	1-218-965-11	RES-CHIP 10K 5% 1/16W

Note 1 :

A service for IC201 is not available because an adjustment is required before replacement.

Note 2:

SHORT CHIP is mounted to the location where L701 and L703 are printed.

Ref. No.	Part No.	Description				Ref. No.	Part No.	Description			
R131	1-218-965-11	RES-CHIP	10K	5%	1/16W	R541	1-218-969-11	RES-CHIP	22K	5%	1/16W
R132	1-218-965-11	RES-CHIP	10K	5%	1/16W	R542	1-218-969-11	RES-CHIP	22K	5%	1/16W
R133	1-208-935-11	METAL CHIP	100K	0.5%	1/16W	R543	1-218-977-11	RES-CHIP	100K	5%	1/16W
R135	1-208-911-11	METAL CHIP	10K	0.5%	1/16W	R544	1-218-977-11	RES-CHIP	100K	5%	1/16W
R136	1-218-973-11	RES-CHIP	47K	5%	1/16W	R545	1-218-977-11	RES-CHIP	100K	5%	1/16W
R137	1-208-943-11	METAL CHIP	220K	0.5%	1/16W	R546	1-218-977-11	RES-CHIP	100K	5%	1/16W
R138	1-218-965-11	RES-CHIP	10K	5%	1/16W	R547	1-218-977-11	RES-CHIP	100K	5%	1/16W
R139	1-218-965-11	RES-CHIP	10K	5%	1/16W	R548	1-218-977-11	RES-CHIP	100K	5%	1/16W
R140	1-218-981-11	RES-CHIP	220K	5%	1/16W	R549	1-218-977-11	RES-CHIP	100K	5%	1/16W
R141	1-218-981-11	RES-CHIP	220K	5%	1/16W	R553	1-218-977-11	RES-CHIP	100K	5%	1/16W
R144	1-218-965-11	RES-CHIP	10K	5%	1/16W	R555	1-218-985-11	RES-CHIP	470K	5%	1/16W
R145	1-218-965-11	RES-CHIP	10K	5%	1/16W	R557	1-218-967-11	RES-CHIP	15K	5%	1/16W
R147	1-218-990-81	SHORT CHIP	0			R558	1-218-967-11	RES-CHIP	15K	5%	1/16W
R148	1-218-953-11	RES-CHIP	1K	5%	1/16W	R602	1-218-929-11	RES-CHIP	10	5%	1/16W
R150	1-218-990-81	SHORT CHIP	0			R603	1-218-939-11	RES-CHIP	68	5%	1/16W
R152	1-218-990-81	SHORT CHIP	0			R604	1-218-955-11	RES-CHIP	1.5K	5%	1/16W
R153	1-218-965-11	RES-CHIP	10K	5%	1/16W	R605	1-218-985-11	RES-CHIP	470K	5%	1/16W
R301	1-218-853-11	METAL CHIP	1.8K	0.5%	1/10W	R606	1-218-972-11	RES-CHIP	39K	5%	1/16W
R302	1-218-859-11	METAL CHIP	3.3K	0.5%	1/10W	R607	1-218-957-11	RES-CHIP	2.2K	5%	1/16W
R304	1-218-977-11	RES-CHIP	100K	5%	1/16W	R651	1-218-965-11	RES-CHIP	10K	5%	1/16W
R307	1-218-953-11	RES-CHIP	1K	5%	1/16W	R652	1-218-965-11	RES-CHIP	10K	5%	1/16W
R308	1-218-977-11	RES-CHIP	100K	5%	1/16W	R713	1-218-978-11	RES-CHIP	120K	5%	1/16W
R309	1-218-990-81	SHORT CHIP	0			R714	1-218-989-11	RES-CHIP	1M	5%	1/16W
R310	1-218-933-11	RES-CHIP	22	5%	1/16W	R715	1-218-977-11	RES-CHIP	100K	5%	1/16W
R311	1-218-990-81	SHORT CHIP	0			R716	1-218-977-11	RES-CHIP	100K	5%	1/16W
R312	1-218-990-81	SHORT CHIP	0			R747	1-218-990-81	SHORT CHIP	0		
R313	1-218-990-81	SHORT CHIP	0			R749	1-218-990-81	SHORT CHIP	0		
R314	1-218-990-81	SHORT CHIP	0			R751	1-218-977-11	RES-CHIP	100K	5%	1/16W
R316	1-218-990-81	SHORT CHIP	0			R752	1-218-945-11	RES-CHIP	220	5%	1/16W
R318	1-218-990-81	SHORT CHIP	0			< SENSOR >					
R319	1-218-990-81	SHORT CHIP	0			SE501	1-479-022-51	SENSOR,ANGULAR VELOCITY (PITCH)			
R320	1-218-990-81	SHORT CHIP	0			SE502	1-479-022-61	SENSOR,ANGULAR VELOCITY (YAW)			
R321	1-218-990-81	SHORT CHIP	0			< VIBRATOR >					
R409	1-208-715-11	METAL CHIP	22K	0.5%	1/16W	X001	1-767-994-23	VIBRATOR,CRYSTAL 32.768kHz			
R410	1-208-715-11	METAL CHIP	22K	0.5%	1/16W	* X101	1-813-403-21	QUARTZ CRYSTAL OSCILLATOR 12MHz			
R411	1-208-927-11	METAL CHIP	47K	0.5%	1/16W						
R432	1-211-969-11	METAL CHIP	10	0.5%	1/10W						
R433	1-211-969-11	METAL CHIP	10	0.5%	1/10W						
R434	1-211-969-11	METAL CHIP	10	0.5%	1/10W						
R435	1-211-969-11	METAL CHIP	10	0.5%	1/10W						
R437	1-218-948-11	RES-CHIP	390	5%	1/16W						
R438	1-218-948-11	RES-CHIP	390	5%	1/16W						
R509	1-208-721-11	METAL CHIP	39K	0.5%	1/16W						
R511	1-218-970-11	RES-CHIP	27K	5%	1/16W						
R512	1-208-695-11	METAL CHIP	3.3K	0.5%	1/16W						
R513	1-208-909-11	METAL CHIP	8.2K	0.5%	1/16W						
R515	1-208-911-11	METAL CHIP	10K	0.5%	1/16W						
R517	1-208-721-11	METAL CHIP	39K	0.5%	1/16W						
R519	1-218-970-11	RES-CHIP	27K	5%	1/16W						
R520	1-208-695-11	METAL CHIP	3.3K	0.5%	1/16W						
R521	1-208-909-11	METAL CHIP	8.2K	0.5%	1/16W						
R524	1-208-911-11	METAL CHIP	10K	0.5%	1/16W						
R526	1-218-965-11	RES-CHIP	10K	5%	1/16W						
R527	1-218-990-81	SHORT CHIP	0								
R535	1-218-989-11	RES-CHIP	1M	5%	1/16W						
R536	1-218-989-11	RES-CHIP	1M	5%	1/16W						
R537	1-218-965-11	RES-CHIP	10K	5%	1/16W						
R538	1-218-965-11	RES-CHIP	10K	5%	1/16W						
R539	1-218-969-11	RES-CHIP	22K	5%	1/16W						
R540	1-218-969-11	RES-CHIP	22K	5%	1/16W						

**SONY BRASIL LTDA.
ENGENHARIA DA QUALIDADE
Julho / 2006**

<http://www.sony.com.br>



Guia de Comandos Básicos do Acrobat Reader 5.05



Adobe® Acrobat®

Esta é a tela do programa, quando se abre um manual:

CMT-RB5

MANUAL DE SERVIÇO

Brazilian Model

Modelo que usa mecanismo similar	NEW
Tipo do Mecanismo do CD	CDM55C-K6BD38
Nome da Base da Unidade	BU-K6BD38
Nome da Unidade Óptica	KSM-213DCP

ESPECIFICAÇÕES

Amplicador

Potência de Saída RMS: 12x12 watts (4 ohms a 1 kHz, 30%THD)

Entrada

MD/VIDEO (AUDIO) IN (conectado RCA): sensibilidade 500/250 mV, impedância 47 kilômetros

Saídas

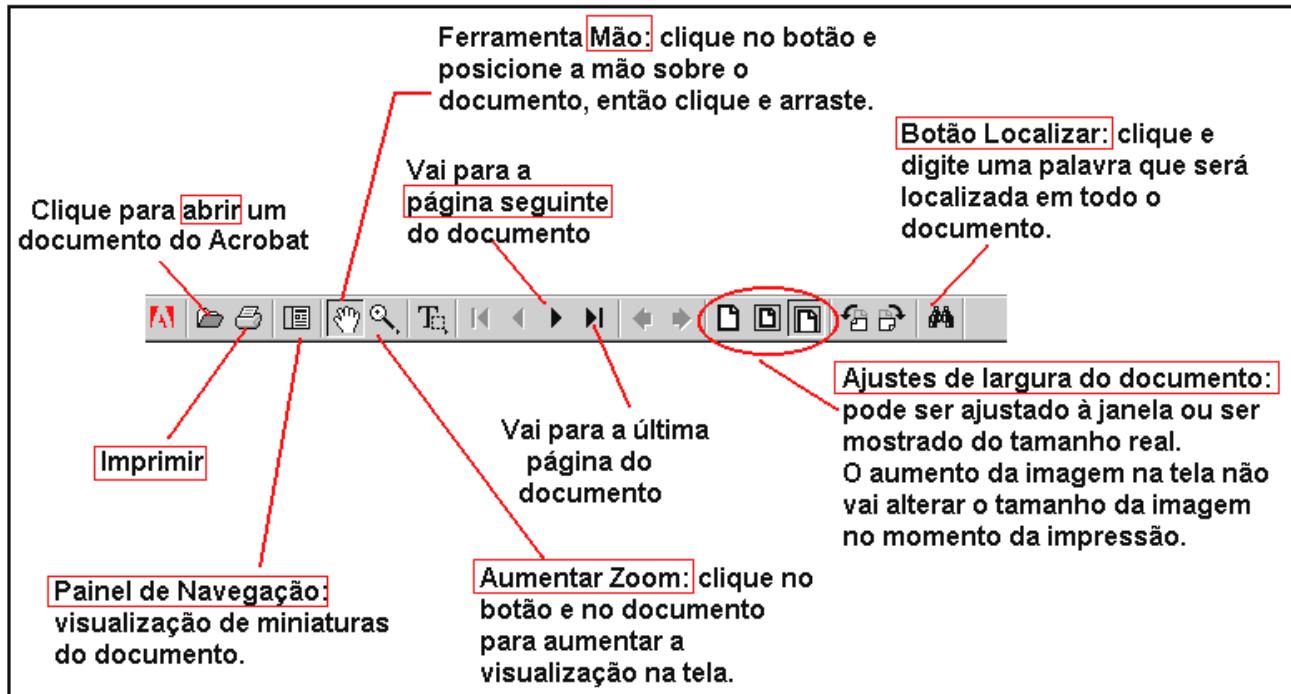
MD/VIDEO (AUDIO) OUT (conectado RCA): 12x12 watts (4 ohms a 1 kHz, 30%THD), impedância 1 kilômetro

Sintonizador AM

Frequência: 530 - 1.600 kHz, sensibilidade 10 microvolts

101% 1 of 34 8,26 x 11,69 in

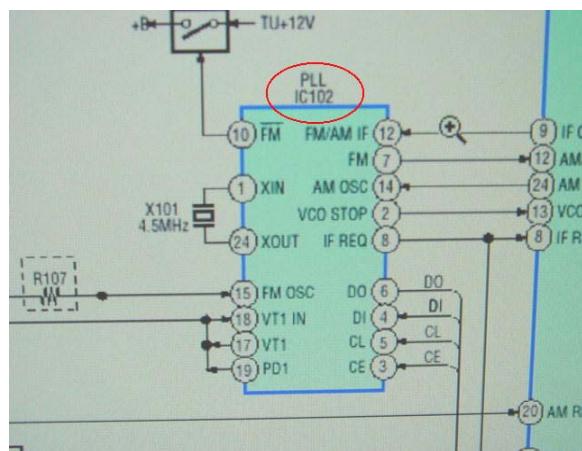
Barra de Comandos



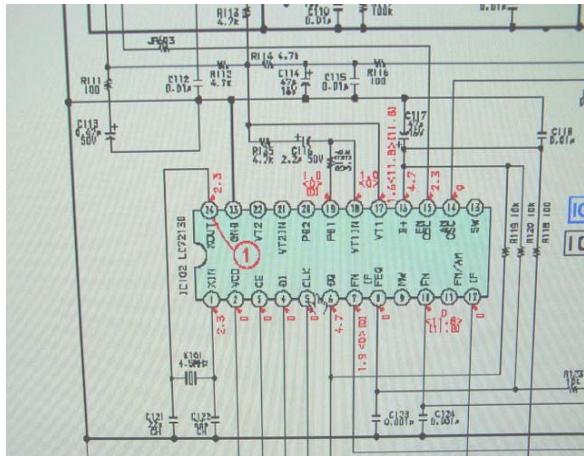
Recurso de Localização de Componentes

Alguns manuais de serviço estão habilitados com uma função que permite localizar mais facilmente um circuito integrado (IC) em seu diagrama esquemático correspondente, diagrama em blocos ou placa de circuito impresso.

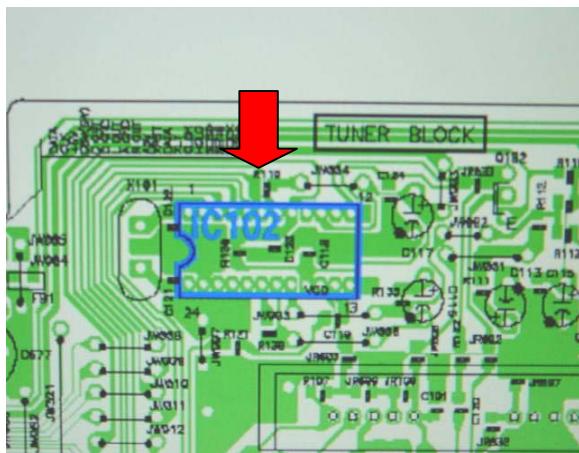
Para isso, abra um manual de serviço, por exemplo o do MHC-DX30 e visualize uma página da lista de peças elétricas, onde existam alguns IC's listados. Ao posicionar o ponteiro do mouse sobre a linha onde está um IC, sobre sua localização, ou valor, você vai verificar que aparece uma “mãozinha”, na verdade, o dedo indicador que fica apontando a linha. Se você der um clique, você será levado pelo programa à pagina do diagrama esquemático onde se encontra o referido IC que você selecionou. Vamos ilustrar o que foi explicado logo a seguir:



Abra a página correspondente ao diagrama em bloco e posicione o ponteiro do mouse sobre o IC escolhido . Quando o cursor tornar-se uma “mãozinha” dê um clique sobre o IC.



O programa trará você à página do diagrama esquemático correspondente que contém o IC escolhido. Clique novamente sobre o IC.



O programa trará você à página correspondente a placa de circuito impresso que contém o IC escolhido. Clique novamente sobre o IC. sobre o IC.

* GND1	1-537-738-21	TERMINAL, EARTH
< IC >		
IC101	8-759-652-00	IC BA1450
IC102	8-759-288-54	IC LC72130
IC201	8-759-242-58	IC TA8189N
IC301	8-759-832-80	IC BH3878KS2
IC401	6-800-194-01	IC M30622MCA-B23FP
IC661	8-759-635-46	IC M51943BSL-TP
IC681	8-759-039-69	IC uPC7805AHF
IC682	8-759-039-69	IC uPC7805AHF
IC683	8-759-088-08	IC uPC7812AHF
IC684	8-759-604-31	IC M5F7809L

Por fim o programa visualiza o ponto da lista de peças onde o IC escolhido está localizado. Ao clicar novamente sobre o componente o ciclo se repete (diagrama em bloco, esquemático, placa de circuito impresso e lista de peças. Vale lembrar que nem todos os manuais de serviço possuem esse recurso.

Notas

- O tamanho da visualização do documento na tela em nada altera o tamanho de impressão. O Zoom de aumento ou de diminuição serve apenas para oferecer mais detalhes ou um aspecto geral do documento visualizado.

- O painel de navegação serve para agilizar o acesso a outras páginas que não estão sendo visualizadas. Para visualizar uma dessas miniaturas em seu tamanho normal, basta clicar duas vezes sobre ela e então esta será exibida na tela.
- Não é possível alterar texto, figuras ou qualquer item do documento no Acrobat Reader 5.0. Este programa é usado somente para visualização e impressão de documentos PDF.
- Diagramas e demais folhas do documentos PDF só poderão ser impressos em tamanho maior caso a impressora suporte papel com dimensão superior ao A4, carta ou semelhante. Do contrário só poderá ser impresso no tamanho A4 padrão.

Engenharia da Qualidade – Novembro 2003

teruaki_nakagawa@ssp.br.sony.com

VOLTAR

SONY

Sony Brasil Ltda.

Engenharia da Qualidade - SSP



Orientação de Impressão no Acrobat Reader 5.05

Dê o primeiro passo! Adquira o Acrobat 5.0 e:

- Converta facilmente os documentos para Adobe PDF
- Compartilhe comentários e aprove ou proteja documentos com eficiência

Em muito mais!

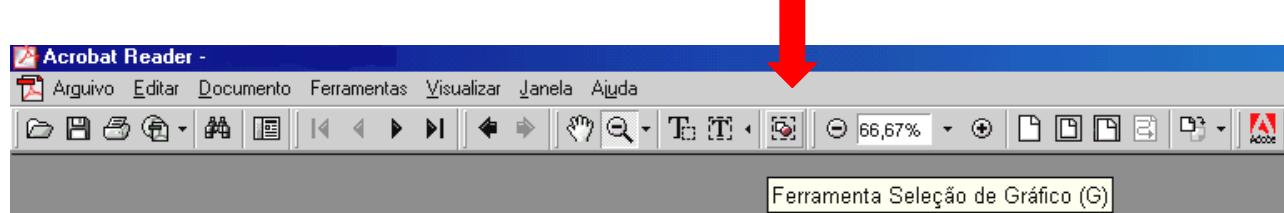
Copyright © 1987-2001 Adobe Systems Incorporated e seus outorgantes. Todos os direitos reservados. Adobe, o logotipo Adobe, Acrobat, o logotipo Acrobat, PostScript e o logotipo PostScript são marcas registradas ou comerciais da Adobe Systems Incorporated nos Estados Unidos e/ou outros países.

É possível imprimir alguns quadros pré-selecionados de forma ampliada no Acrobat Reader. Esse comando é muito útil quando é necessária fazer a impressão de diagramas elétricos.

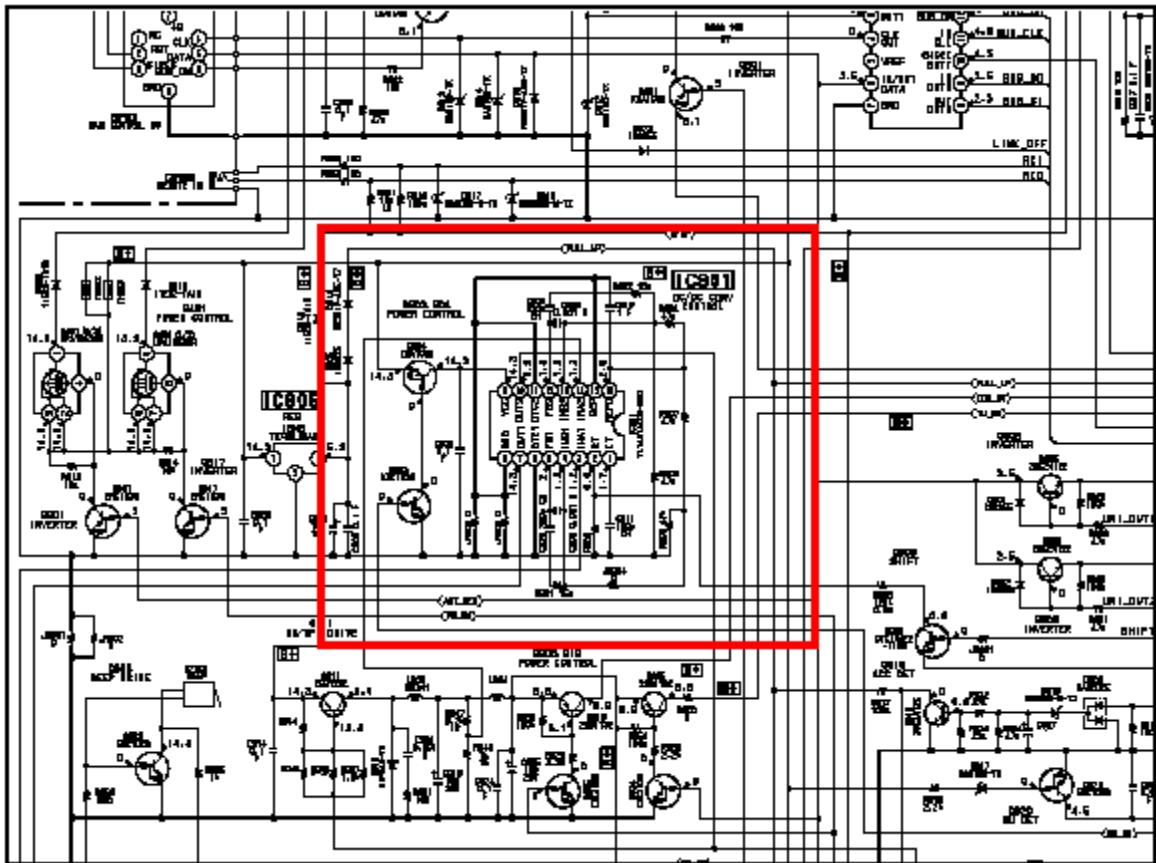
A sequência abaixo mostra, passo a passo como selecionar uma parte de uma folha qualquer (nesse exemplo usaremos um diagrama elétrico) e configurar sua impressão.

Temos no Acrobat Reader a barra abaixo. Leve o cursor do mouse até o botão indicado pela seta e fique pressionando o botão do mouse.

Segurando o botão uma barra oculta aparecerá, então expanda conforme abaixo. O botão final a ser clicado para que o comando seja selecionado é o da **FERRAMENTA DE SELEÇÃO DE GRÁFICO (G)**



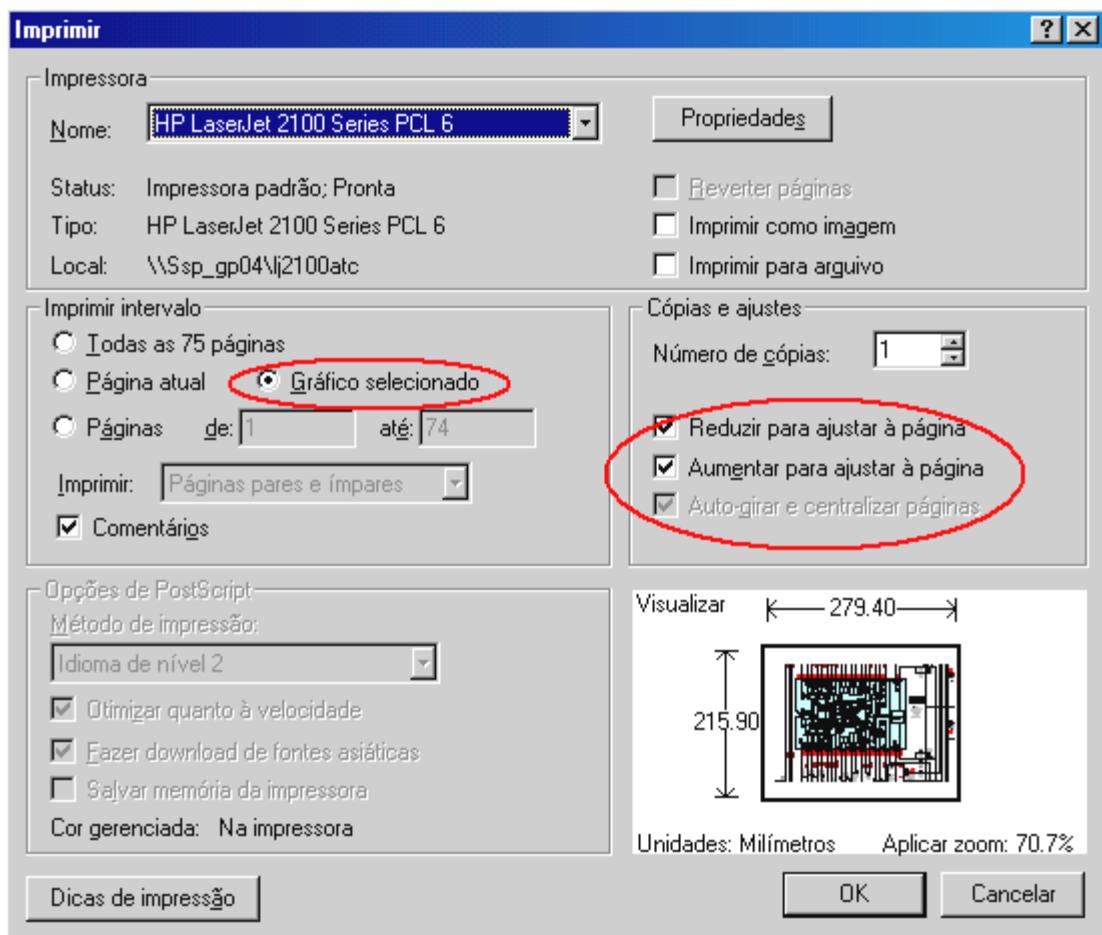
Agora com o cursor selecione uma área do diagrama que deseja imprimir de forma ampliada. A área escolhida nesse exemplo é o quadrado de linhas espessas.



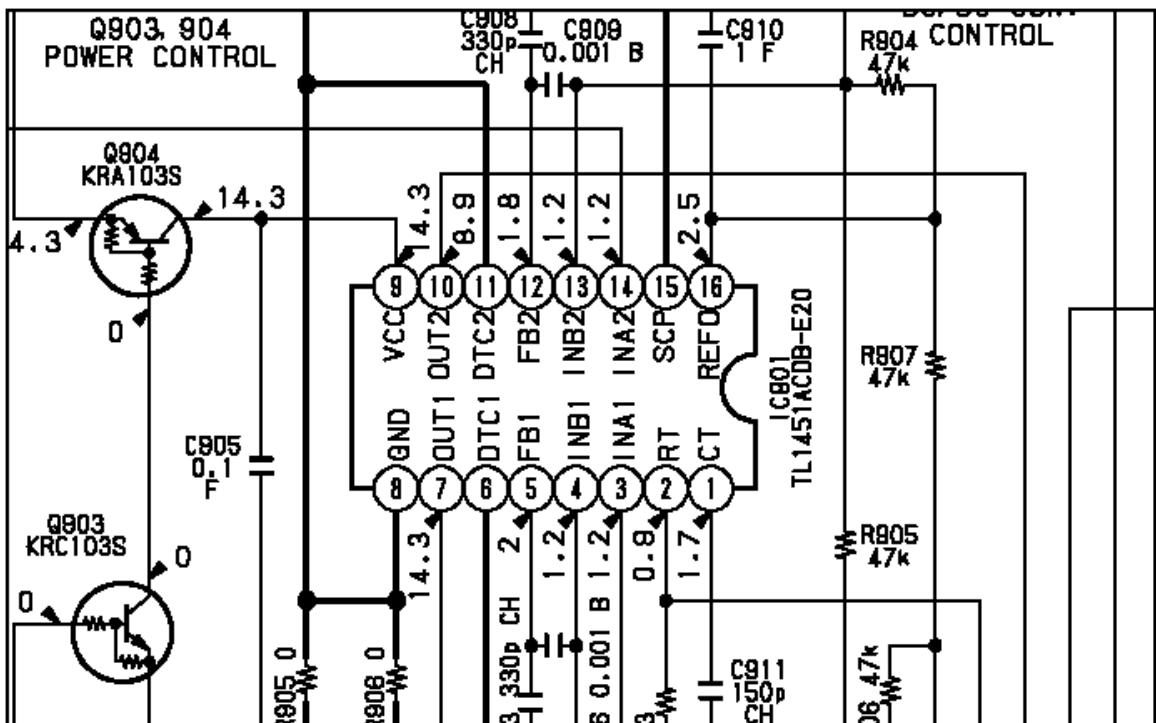
Agora vá até o menu de impressão seguindo o procedimento a seguir, clicando em **IMPRIMIR**, indicado pela seta:



Na janela que se abre verifique se as opções indicadas em vermelho (circuladas) estão habilitadas. Assim, quando imprimir a área do gráfico, esta parte será expandida por toda a folha de papel A4.



Após a impressão verificamos que o diagrama ficou realmente ampliado, conforme exemplo:



Notas

O mesmo procedimento pode ser repetido para outras páginas dos manuais, como lista de peças, bem como pode ser utilizado papel tamanho A3 (420 x 297 mm) para impressoras que suportem esse formato.

Outros comandos podem ser encontrados no “**Guia de Comandos Básicos do Acrobat Reader**”, que também consta neste CD e em anteriores.

Lembramos novamente que não é possível alterar texto, figuras ou qualquer item do documento no Acrobat Reader 5.05. Este programa é usado somente para visualização e impressão de documentos PDF.

Mais informações podem ser obtidas em “**Ajuda**”.

Dúvidas e sugestões devem ser encaminhadas para **Teruaki** através do e-mails:



teruaki_nakagawa@ssp.br.sony.com